

# UC25HQ16

## Ultra Low Power, 16M-bit

## Serial Multi I/O Flash Memory Datasheet

## **Key Features**

- > Wide supply range from 2.3V to 3.6V for Read, Erase and Program
- > Ultra-Low Power consumption for Read, Erase and Program
- > x1, x2 and x4 Multi I/O, QPI Support
- > High reliability with 100K cycling endurance and 20-year data retention

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## **1. GENERAL DESCRIPTIONS**

The UC25HQ16 (16M-Bit) serial flash supports the standard Serial Peripheral Interface (SPI), and supports the Dual/Quad SPI and QPI : Serial Clock, Chip Select, Serial Data I/O0 (SI), I/O1 (SO), I/O2 (WP#), and I/O3 (HOLD#).

The Dual I/O & Dual output data is transferred with speed of 208Mbits/s and the Quad I/O & Quad output data is transferred with speed of 416Mbits/s.

Specifically designed for use in many different systems, the device supports read, program, and erase operations with a wide supply voltage range of 2.3V to 3.6V. No separate voltage is required for programming and erasing.

## 2. FEATURES

- SPI Flash Memories
  - -Densities: 16Mbit
  - -Standard SPI: SCLK, CS#, SI, SO
  - -Dual SPI: SCLK, CS#, IO0, IO1
  - -Quad SPI: SCLK, CS#, IO0, IO1, IO2, IO3
  - -QPI: SCLK, CS#, IO0, IO1, IO2, IO3

## Highest Performance Serial Flash

- -104MHz for fast read
- -Dual I/O Data transfer up to 208Mbits/s
- -Quad I/O Data transfer up to 416Mbits/s
- -QPI Mode Data transfer up to 416Mbits/s
- -Minimum 100,000 Program/Erase Cycles
- -More than 20-year data retention

### • Low Power Consumption

- -Single 2.3V to 3.6V supply
- -10µA standby current
- -0.3µA deep power down current
- -2.5mA active read current at 33MHz
- -3.0mA active program or erase current

- Flexible Architecture
  - Uniform 256-byte Page Erase
  - Uniform 4K-byte Sector Erase
  - -Uniform 32/64K-byte Block Erase
  - -Program 1 to 256 byte per programmable page

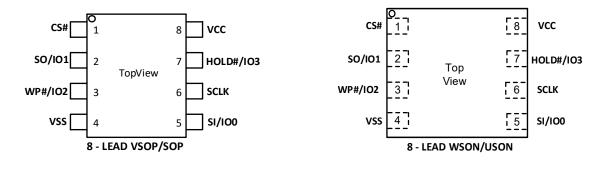
## Fast Program and Erase Speed

- 2ms page program time
- 12ms page erase time
- -12ms 4K-byte sector erase time
- 12ms 32K/64K-byte block erase time
- Advanced Security Features
  - 128-Bit Unique ID for each device
  - 3\*1024-Byte Security Registers with OTP Locks
  - Discoverable parameters (SFDP) register
- Package Information
  - SOP8 150MIL
  - TSSOP-8
  - USON-8
  - -WSON-8
  - Contact UCUN for KGD and other options



## 3. PIN DEFINITION

## 3.1 PIN CONFIGURATION

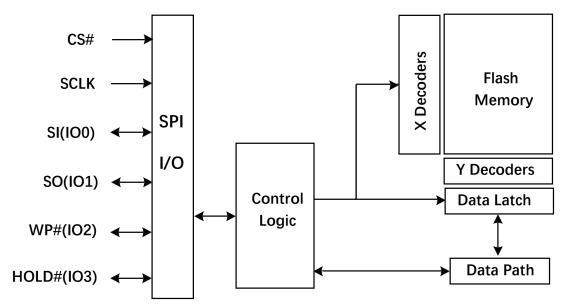


### 3.2 PIN DESCRIPTION

Table-1. Pin Definition

Pin No.	Pin Name	I/O	Description		
1	CS#	-	Chip Select Input		
2	SO (IO1)	I/O	Data Output (Data Input Output 1)		
3	WP# (IO2)	I/O	Write Protect Input (Data Input Output 2)		
4	VSS		Ground		
5	SI (IO0)	I/O	Data Input (Data Input Output 0)		
6	SCLK		Serial Clock Input		
7	HOLD# (IO3)	I/O	Hold Input (Data Input Output 3)		
8	VCC		Power Supply		

## 4. BLOCK DIAGRAM



## 5. MEMORY ORGANIZATION

rabio 11 001011Q1074114y organization								
Each device has	Each block has	Each sector has	Each page has					
2M	64/32K	4K	256	Bytes				
8K	256/128	16	-	Pages				
512	16/8	-	-	Sectors				
32/64	-	-	_	Blocks				

#### Table-2. UC25HQ16 Array Organization

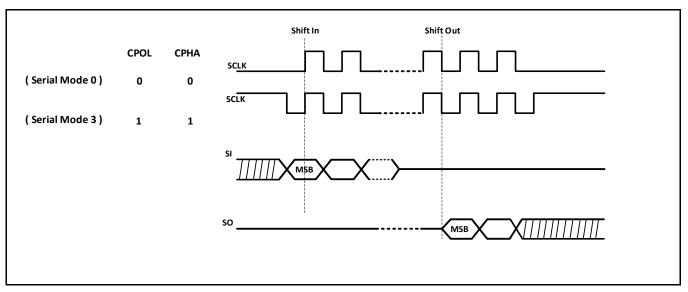
Table-3. UC25HQ16 Uniform Block Sector Architecture

Block	Sector	Addres	ss range
	511	1FF000H	1FFFFFH
31	•••••		
	496	1F0000H	1F0FFFH
	495	1EF000H	1EFFFFH
30	•••••		
	480	1E0000H	1E0FFFH
	•••••		•••••
	•••••		•••••
	•••••		•••••
	•••••		•••••
	47	02F000H	02FFFFH
2	•••••		•••••
	32	020000H	020FFFH
	31	01F000H	01FFFFH
1	•••••		•••••
	16	010000H	010FFFH
	15	00F000H	00FFFFH
0			
	0	000000H	000FFFH



## 6. DEVICE OPERATION

- 1. Before a command is issued, the status register should be checked to ensure the device is ready for the intended operation.
- 2. When an incorrect command is input, the device enters standby mode and remains in standby mode until the next CS# falling edge. In standby mode, the SO pin of the device is in High-Z.
- 3. When the correct command is input, the device enters active mode and remains in active mode until the next rising edge of CS#.
- 4. For standard single data rate serial mode, input data is latched on the rising edge of Serial Clock (SCLK) and data is shifted out on the falling edge of SCLK. The difference between Serial mode 0 and mode 3 is shown in Figure-1.



## Figure-1. Serial Modes Supported (for Normal Serial Mode)

## Standard SPI

The UC25HQ16 features a serial peripheral interface on 4 signals: Serial Clock (SCLK), Chip Select (CS#), Serial Data Input (SI) and Serial Data Output (SO). Both SPI bus mode 0 and 3 are supported. Input data is latched on the rising edge of SCLK and is data shifted out on the falling edge of SCLK. **Dual SPI** 

The UC25HQ16 supports Dual SPI operation when using the "Dual Output Fast Read" (3BH), "Dual I/O Fast Read" (BBH), "Dual I/O Read Manufacture ID & Device ID" (92H) and "Dual Input Page Program" (A2H) commands. These commands allow data to be transferred to or from the device at twice the rate of the standard SPI. When using the Dual SPI command, the SI and SO pins become bidirectional I/O pins: IO0 and IO1.

## Quad SPI

The UC25HQ16 supports Quad SPI operation when using the "Quad Output Fast Read" (6BH), "Quad I/O Fast Read" (EBH/E7H/E3H), "Quad I/O Read Manufacture ID/Device ID" (94H) and "Quad Input Page Program" (32H) commands. These commands allow data to be transferred to or from the device at four times the rate of the standard SPI. When using the Quad SPI command, the SI, SO, WP# and HOLD# pins become bidirectional I/O pins: IO0, IO1, IO2 and IO3, respectively. Quad SPI commands require the non-volatile Quad Enable bit (QE) in Status Register to be set.



### QPI

The UC25HQ16 supports Quad Peripheral Interface (QPI) operations only when the device is switched from Standard/Dual/Quad SPI mode to QPI mode using the "Enable the QPI (38H)" command. The QPI mode utilizes all four IO pins to input the command code. Standard/Dual/Quad SPI mode and QPI mode are exclusive. Only one mode can be active at any given times. "Enable the QPI (38H)" and "Disable the QPI (FFH)" commands are used to switch between these two modes. Upon power-up and after software reset using "Reset (99H)" command, the default state of the device is Standard/Dual/Quad SPI mode. The QPI mode requires the non-volatile Quad Enable bit (QE) in Status Register to be set.

## Hold

Driving the HOLD# pin low will pause any serial communications with the device. The HOLD feature will not stop the following operations if already in progress when the HOLD# pin goes low: status register write, program, or erase.

The operation of HOLD requires Chip Select (CS#) to remain low and begins on the falling edge of HOLD# pin signal while the Serial Clock (SCLK) signal is low (if the Serial Clock signal is not low, the HOLD operation will not start until the Serial Clock signal is low). The HOLD condition ends on the rising edge of HOLD# pin signal while the Serial Clock (SCLK) signal is low (if the Serial Clock signal is not low, the HOLD operation will not end until the Serial Clock is low).

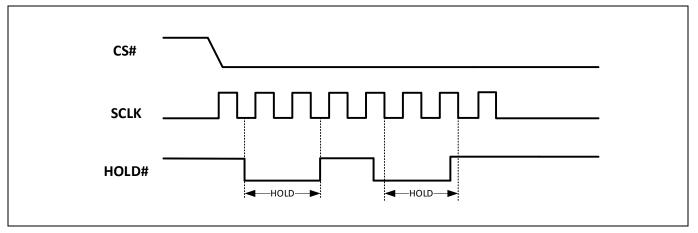


Figure-2. Hold Condition

During the HOLD operation, the Serial Data Output (SO) is in a high impedance state when the HOLD# pin goes low and will remain in a high impedance state until the HOLD# pin goes high. The Serial Data Input (SI) is ignored (don't care) if both the Serial Clock (SCLK) and HOLD# pin go low and will remain in this state until the SCLK goes low and the HOLD# pin goes high. If Chip Select (CS#) is driven high during the HOLD operation, it will reset the internal logic of the device. To re-start communication with chip, the HOLD# must be driven high and CS# must be at a logic low.

Note: The HOLD feature is disabled in Quad I/O and QPI mode.



## 7. STATUS REGISTER AND CONFIGURATION REGISTER

## 7.1 Status Register (SR)

S15	S14	S13	S12	S11	S10	S9	S8		
SUS	СМР	LB3	LB2 LB1		EP_FAIL	QE	SRP1		
Read-only	Non-volatile	Non-volatile OTP			Read-only	Non-volatile	Non-volatile		

## Table-4. Status Register

S7	S6	S5	S4	S3	S2	S1	S0
SRP0	BP4	BP3	BP2	BP1	BP0	WEL	WIP
Non-volatile			Read-only	Read-only			

The status and control bits of the Status Register are as follows:

#### WIP bit

The Write in Progress (WIP) bit indicates whether the device is busy executing a program/erase/write status register operation. When the Write in Progress (WIP) bit is set to 1, a program/erase/write status register operation is in progress. When the Write in Progress (WIP) bit is set to 0, the device does not have a program/erase/write status register operation in progress.

#### WEL bit

The Write Enable Latch (WEL) bit indicates the status of the internal Write Enable Latch. When set to 1, the internal Write Enable Latch is set, when set to 0 the internal Write Enable Latch is reset, and no Write Status Register, Program or Erase command is accepted.

#### BP4, BP3, BP2, BP1, BP0 bits

The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits are non-volatile. They define the size of the area software protected against Program and Erase commands. These bits are written with the Write Status Register (01H) command. When the Block Protect (BP4, BP3, BP2, BP1, BP0) bits are set to the target value, the relevant memory area (as defined in Table-7.X) becomes protected against Page Program (02H), Page Erase (81H), Sector Erase (20H), Half Block Erase (52H) and Block Erase (D8H) commands. The Chip Erase (60H or C7H) command is executed, only if the Block Protect bits are set to "None protected". The Block Protect bits can be written if the Hardware Protection Mode has not been set.

#### SRP1, SRP0 bits

The Status Register Protect (SRP1 and SRP0) bits are non-volatile Read/Write bits in the status register. The SRP bits control the method of write protection: software protection, hardware protection, power supply lock-down or one-time programmable protection.

SRP1	SRP0	#WP	Status Register	Description
0	0	х	Software Protected	The Status Register can be written to after a Write Enable command, WEL=1. (Default)
0	1	0	Hardware Protected	WP#=0, the Status Register is locked and cannot be written to.
0	1	1	Hardware Unprotected	WP#=1, the Status Register is unlocked and can be written to after a Write Enable command, WEL=1.
1	0	х	Power Supply Lock-Down <sup>(1)</sup>	Status Register is protected and cannot be written to again until the next Power-Down, Power-Up cycle.
1	1	х	One Time Program <sup>(2)</sup>	Status Register is permanently protected and cannot be written to.

### Table-5. Status Register Protection Bits

#### Notes:

- 1. When SRP1, SRP0= (1, 0), a Power-Down, Power-Up cycle will change SRP1, SRP0 to (0, 0) state.
- 2. This feature is available on special order. Please contact UCUN for details.

### QE bit

The Quad Enable (QE) bit is a non-volatile Read/Write bit in the Status Register that allows Quad operation. When the QE bit is set to 0 (Default) the device is set to Standard SPI operation and both WP# and HOLD# pins are enabled. When the QE bit is set to 1, the Quad IO2 and IO3 pins are enabled and the WP# pin function is not available since this pin is used for IO2. (Set the QE bit to 0 to avoid short issue if the WP# or HOLD# pin is tied directly to the power supply or ground.)

### **EP\_FAIL** bit

The Erase/Program Fail bit is a read only bit which shows the status of the last Program/Erase operation. The bit will be set to "1" if the program/erase operation failed or interrupted by reset or the program/erase region was protected. It will be automatically cleared to "0" if the next program/erase operation succeeds. Please note that it will not interrupt or stop any operation in the flash memory.

### LB3, LB2, LB1 bits

The LB3, LB2, LB1 bits are non-volatile One Time Program (OTP) bits in Status Register (S13-S11) that provide the write protect control and status for the Security Registers. The default state of LB3-LB1 is 0, with the security registers unprotected. The LB3-LB1 bits can be set to 1 individually using the Write Register (01H or 31H) command. The LB3-LB1 bits are One Time Programmable, once setting to 1, the corresponding Security Registers will become read-only permanently.

### CMP bit

The CMP bit is a non-volatile Read/Write bit in the Status Register (S14). It is used in conjunction with the BP4-BP0 bits to provide more flexibility for the memory array protection. Please see the Table-7.X for protect area details. The default setting is CMP=0.

#### SUS bit

The SUS bit is read only bit in the status register (S15) that is set to 1 after executing a Program/Erase Suspend (75H or B0H) command. The SUS bit is cleared to 0 by the Program/Erase Resume (7AH or 30H)

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command, the Software Reset (66H+99H) command as well as a power-down, power-up cycle.

## 7.2 Configuration Register (CR)

C7	C6	C5	C4	C3	C2	C1	C0		
Reserved	DRV1	DRV0	QP	Reserved	Reserved	Reserved	DC		
	Non-volatile	Non-volatile	Volatile				Non-volatile		

Table 6. Status Register

## QP bit

The Quad Page (QP) bit is a volatile Read/Write bit in the Configure Register that allows Quad Page operation. When the QP bit is set to 0 (Default) the page size is 256bytes. When the QP pin is set to 1, the page size is 1024bytes.

This bit controls the page programming buffer address wrap point. Legacy SPI devices generally have used a 256 Byte page programming buffer and defined that if data is loaded into the buffer beyond the 255 Byte locations, the address at which additional bytes are loaded would be wrapped to address zero of the buffer. The UC25HQ16 provides a 1024Byte page programming buffer that can increase programming performance. For legacy software compatibility, this configuration bit provides the option to continue the wrapping behavior at the 256 Byte boundary or to enable full use of the available 1024Byte buffer by not wrapping the load address at the 256 Byte boundary.

When the QP pin is set to 1, the page erase instruction(81h) will erase the data of the chosen Quad Page to be "1".

#### DRV1 & DRV0 bit

The DRV1 & DRV0 bits are non-volatile Read/Write bits which are used to determine the output driver strength for the Read operations.

DRV1,DRV0	Drive Strength
0,0	80%
0,1	40%
1,0	100%
1,1(default)	60%

#### DC bit

The Dummy Configuration (DC) bit is non-volatile, which selects the number of dummy cycles between the end of address and the start of read data output. Dummy cycles provide additional latency that is needed to complete the initial read access of the flash array before data can be returned to the host system. Some read commands require additional dummy cycles as the SCLK frequency increases.

Command	DC bit	Numbers of Dummy Cycles	Freq.(MHz)
BBH	0 (default)	4	66
DDN	1	8	85
	0 (default)	6	66
EBH	1	10	85

The following dummy cycle tables provide different dummy cycle settings that are configured



## 8. DATA PROTECTION

During power transition, there may be some false system level signals which result in inadvertent erasure or programming. The device is designed to protect itself from these accidental write cycles.

The state machine will be reset to standby mode automatically during power up. In addition, the control register architecture of the device ensures that the memory contents can only be changed after specific command sequences have completed successfully.

In the following, there are several features to protect the system from the accidental write cycles during VCC power-up and power-down or from system noise.

- Valid command length checking: The command length will be checked whether it is at byte base and completed on byte boundary.
- Write Enable (06H) command: WREN command is required to set the Write Enable Latch bit (WEL) before issuing other commands to change data.
- Software Protection Mode: The Block Protect (BP4, BP3, BP2, BP1, and BP0) bits define the section of the memory array that can be read but not changed.
- Hardware Protection Mode: WP# going low to protect the CMP, BP0~BP4 bits and SRP0~1 bits.
- Deep Power-Down Mode: By entering deep power down mode, the flash device is ignores all commands until the Release from Deep Power-Down Mode (B9H) command.

		Status bi	t		Memory Content				
BP4 BP3 BP2 BP1 BP0		Blocks	Addresses	Density	Portion				
х	х	0	0	0	NONE	NONE	NONE	NONE	
0	0	0	0	1	31	1F0000H-1FFFFFH	64KB	Upper 1/32	
0	0	0	1	0	30 and 31	1E0000H-1FFFFFH	128KB	Upper 1/16	
0	0	0	1	1	28 to 31	1C0000H-1FFFFFH	256KB	Upper 1/8	
0	0	1	0	0	24 to 31	180000H-1FFFFFH	512KB	Upper 1/4	
0	0	1	0	1	16 to 31	100000H-1FFFFFH	1MB	Upper 1/2	
0	1	0	0	1	0	000000H-00FFFFH	64KB	Lower 1/32	
0	1	0	1	0	0 and 1	000000H-01FFFFH	128KB	Lower 1/16	
0	1	0	1	1	0 to 3	000000H-03FFFFH	256KB	Lower 1/8	
0	1	1	0	0	0 to 7	000000H-07FFFFH	512KB	Lower 1/4	
0	1	1	0	1	0 to 15	000000H-0FFFFH	1MB	Lower 1/2	
х	х	1	1	х	0 to 31	000000H-1FFFFFH	2MB	ALL	
1	0	0	0	1	31	1FF000H-1FFFFFH	4KB	Upper 1/512	
1	0	0	1	0	31	1FE000H-1FFFFFH	8KB	Upper 1/256	
1	0	0	1	1	31	1FC000H-1FFFFFH	16KB	Upper 1/128	
1	0	1	0	х	31	1F8000H-1FFFFFH	32KB	Upper 1/64	
1	1	0	0	1	0	000000H-000FFFH	4KB	Lower 1/512	
1	1	0	1	0	0	000000H-001FFFH	8KB	Lower 1/256	
1	1	0	1	1	0	000000H-003FFFH	16KB	Lower 1/128	
1	1	1	0	х	0	000000H-007FFFH	32KB	Lower 1/64	

Table-7.1 UC25HQ16 Protected Area Size (CMP bit=0)



		Status bit			Memory Content					
BP4	BP3	BP2	BP1	BP0	Blocks	Addresses Density		Portion		
х	х	0	0	0	0 to 31	000000H-1FFFFH	2MB	ALL		
0	0	0	0	1	0 to 30	000000H-1EFFFFH	1984KB	Lower 31/32		
0	0	0	1	0	0 to 29	000000H-1DFFFFH	1920KB	Lower 15/16		
0	0	0	1	1	0 to 27	000000H-1BFFFFH	1792KB	Lower 7/8		
0	0	1	0	0	0 to 23	000000H-17FFFFH	1536KB	Lower 3/4		
0	0	1	0	1	0 to 15	000000H-0FFFFH	1MB	Lower 1/2		
0	1	0	0	1	1 to 31	010000H-1FFFFFH	1984KB	Upper 31/32		
0	1	0	1	0	2 to 31	020000H-1FFFFFH	1920KB	Upper 15/16		
0	1	0	1	1	4 to 31	040000H-1FFFFFH	1792KB	Upper 7/8		
0	1	1	0	0	8 to 31	080000H-1FFFFFH	1536KB	Upper 3/4		
0	1	1	0	1	16 to 31	100000H-1FFFFFH	1MB	Upper 1/2		
х	х	1	1	х	NONE	NONE	NONE	NONE		
1	0	0	0	1	0 to 31	000000H-1FEFFFH	2044KB	Lower 511/512		
1	0	0	1	0	0 to 31	000000H-1FDFFFH	2040KB	Lower 255/256		
1	0	0	1	1	0 to 31	000000H-1FBFFFH	2032KB	Lower 127/128		
1	0	1	0	х	0 to 31	000000H-1F7FFFH	2016KB	Lower 63/64		
1	1	0	0	1	0 to 31	001000H-1FFFFFH	2044KB	Upper 511/512		
1	1	0	1	0	0 to 31	002000H-1FFFFH	2040KB	Upper 255/256		
1	1	0	1	1	0 to 31	004000H-1FFFFFH	2032KB	Upper 127/128		
1	1	1	0	х	0 to 31	008000H-1FFFFFH	2016KB	Upper 63/64		

#### Table-7.2 UC25HQ16 Protected Area Size (CMP bit=1)

## Notes:

1. X=don't care

2. If any erase or program command specifies a memory that contains protected data portion, this command will be ignored.



## 9. COMMAND DESCRIPTION

All commands, addresses and data are shifted in and out of the device, beginning with the most significant bit on the first rising edge of SCLK after CS# is driven low. Then, the one-byte command code must be shifted into the device starting with the most significant bit on SI. Each bit is latched on the rising edge of SCLK.

The commands supported by UC25HQ16 are listed inTable-8. Every command sequence starts with a one-byte command code. Depending on the command, it might be followed by address or data bytes, or by both or none. CS# must be driven high after the last bit of the command sequence has been completed. For the commands of Read, Fast Read, Read Status Register, Release from Deep Power- Down, and Read Device ID, the shifted-in command sequence is followed by a data-out sequence. All read commands can be completed after any bit of the data-out sequence is shifted out, and then CS# must be driven high to return to deselected status.

For the Page Program, Sector Erase, Half Block Erase, Block Erase, Chip Erase, Write Status Register, Write Enable, Write Disable or Deep Power-Down commands, CS# must be driven high exactly at a byte boundary, otherwise the command is rejected, and is not executed. That means CS# must be driven high when the number of clock pulses after CS# being driven low is an exact multiple of eight. For Page Program, if CS# is driven high at any time the input byte is not a full byte, nothing will happen and WEL will not be reset.

Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8	Byte 9
Write Enable	06H								
Write Disable	04H								
Volatitle SR Write Enable	50H								
Read Status Register-1	05H	(S7-S0)	(cont.)						
Read Status Register-2	35H	(S15-S8)	(cont.)						
Read Configure Register	45/15H	(S7-S0)	(cont.)						
Write Status Register-1	01H	S7-S0							
Write Status Register-1&2	01H	S7-S0	S15-S8						
Write Status Register-2	31H	S15-S8							
Write Configure Register	11H	S7-S0							
Read Data	03H	A23-A16	A15-A8	A7-A0	(D7-D0)	(cont.)			
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)		
Dual Output Fast Read	3BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)		
Quad Output Fast Read	6BH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)		
Read Word Quad I/O	E7H	A23-A16	A15-A8	A7-A0	M7-M0	dummy	(D7-D0)	(cont.)	
Read Octal Word Quad I/O	E3H	A23-A16	A15-A8	A7-A0	M7-M0	(D7-D0)	(cont.)		
Dual I/O Fast Read	BBH	A23-A16	A15-A8	A7-A0	M7-M0	(D7-D0)	(cont.)		
Active Status Interrupt	25H								
Quad I/O Fast Read	EBH	A23-A16	A15-A8	A7-A0	M7-M0	dummy	dummy	(D7-D0)	(cont.)

Table-8. Commands (Standard/Dual/Quad SPI)



## Commands (Standard/Dual/Quad SPI)

Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte8	Byte 9	Byte 10
Set Burst with Wrap	77H	dummy	dummy	dummy	W7-W0	2,100	29101	2,000	29.00	2,10.10
Page Program	02H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte				
Page Write	A5H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte				
Dual-IN Page Program	A2H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte				
Quad Page Program	32H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte				
Page Erase	81H	A23-A16	A15-A8	A7-A0	01 00	HOXE Dyte				
Sector Erase	20H	A23-A16	A15-A8	A7-A0						
Block Erase (32K)	52H	A23-A16	A15-A8	A7-A0						
Block Erase (64K)	D8H	A23-A16	A15-A8	A7-A0						
Chip Erase	C7/60H	71207110	///0///0	74770						
Read Manufacturer/Device	90H	dummy	dummy	A7-A0	(MID7- MID0)	(ID7-ID0)	(cont.)			
Dual I/O Read Manufacturer/Device ID	92H	dummy	dummy	A7-A0	M7-M0	(MID7- MID0)	(ID7- ID0)	(cont.)		
Quad I/O Read Manufacturer/Device ID	94H	dummy	dummy	A7-A0	M7-M0	dummy	dummy	(MID7- MID0)	(ID7- ID0)	(cont.)
Read Identification	9FH	(MID7- MID0)	(ID15- ID8)	(ID7- ID0)	(cont.)					
Read Unique ID	4BH	dummy	dummy	dummy	dummy	(UID7- UID0)	(cont.)			
Erase Security Registers	44H	A23-A16	A15-A8	A7-A0						
Program Security Registers	42H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte				
Read Security Registers	48H	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)			
Enable Reset	66H									
Reset	99H									
Program/Erase Suspend	75H/B0H									
Program/Erase Resume	7AH/30H									
Deep Power-Down	B9H									
Release From Deep Power-Down	ABH									
Release From Deep Power-Down and Read Device ID	ABH	dummy	dummy	dummy	(ID7- ID0)	(cont.)				
Read Serial Flash Discoverable Parameter	5AH	A23-A16	A15-A8	A7-A0	dummy	(D7-D0)	(cont.)			
Enable QPI	38H									



## Command set (QPI)

Command Set (Qr I)								
Command Name	Byte 1	Byte 2	Byte 3	Byte 4	Byte 5	Byte 6	Byte 7	Byte 8
Clock Number	(0,1)	(2,3)	(4,5)	(6,7)	(8,9)	(10,11)	(12,13)	(14,15)
Write Enable	06H							
Write Disable	04H							
Read Config Register bit	45/15H	(S7-S0)	(cont.)					
Read Status Register-1	05H	(S7-S0)	(cont.)					
Read Status Register-2	35H	(S15-S8)	(cont.)					
Write Status Register-1	01H	S7-S0						
Write Status Register-1&2	01H	S7-S0	S15-S8					
Write Status Register-2	31H	S15-S8						
Write Configure Register	11H	S7-S0						
Volatile SR Write Enable	50H							
Fast Read	0BH	A23-A16	A15-A8	A7-A0	dummy	dummy	(D7-D0)	(cont.)
Quad I/O Fast Read	EBH	A23-A16	A15-A8	A7-A0	M7-M0	dummy	(D7-D0)	(cont.)
Page Program	02H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte		
Page Write	A5H	A23-A16	A15-A8	A7-A0	D7-D0	Next Byte		
Page Erase	81H	A23-A16	A15-A8	A7-A0				
Sector Erase	20H	A23-A16	A15-A8	A7-A0				
Block Erase (32K)	52H	A23-A16	A15-A8	A7-A0				
Block Erase (64K)	D8H	A23-A16	A15-A8	A7-A0				
Chip Erase	C7/60H							
Set Read Parameters	C0H	P7-P0						
Manufacturer/Device ID	90H	dummy	dummy	00H	(MID7-MID0)	(ID7-ID0)	(cont.)	
Read Identification	9FH	MID7-MID0	ID15-ID8	ID7-ID0	(cont.)			
Erase Security Registers	44H	A23-A16	A15-A8	A7-A0				
Program Security Registers	42H	A23-A16	A15-A8	A7-A0	(D7-D0)	Next Byte		
Read Security Registers	48H	A23-A16	A15-A8	A7-A0	dummy	dummy	(D7-D0)	(cont.)
Enable Reset	66H							
Reset	99H							
Burst Read with Wrap	0CH	A23-A16	A15-A8	A7-A0	dummy	dummy	(D7-D0)	(cont.)
Program/Erase Suspend	75H							
Program/Erase Resume	7AH							
Deep Power-Down	B9H							
Release from Deep Power-Down Release From Deep	ABH							
Power-Down, And Read Device ID	ABH	dummy	dummy	dummy	(ID7-ID0)	(cont.)		
Disable QPI	FFH							
				1	1		1	



### Notes:

1. Dual Output data

IO0 = (D6, D4, D2, D0) IO1 = (D7, D5, D3, D1)

2. Dual Input Address

IO0 = A22, A20, A18, A16, A14, A12, A10, A8, A6, A4, A2, A0, M6, M4, M2, M0 IO1 = A23, A21, A19, A17, A15, A13, A11, A9, A7, A5, A3, A1, M7, M5, M3, M1

3. Quad Output Data

IO0 = (D4, D0, .....) IO1 = (D5, D1, .....) IO2 = (D6, D2, .....) IO3 = (D7, D3,.....)

4. Quad Input Address

IO0 = A20, A16, A12, A8, A4, A0, M4, M0 IO1 = A21, A17, A13, A9, A5, A1, M5, M1 IO2 = A22, A18, A14, A10, A6, A2, M6, M2 IO3 = A23, A19, A15, A11, A7, A3, M7, M3

5. Fast Read Quad I/O Dummy Bits and Data

IO0 = (x, x, x, x, D4, D0,...) IO1 = (x, x, x, x, D5, D1,...) IO2 = (x, x, x, x, D6, D2,...) IO3 = (x, x, x, x, D7, D3,...)

6. Word Read Quad I/O Data

IO0 = (x, x, D4, D0,...) IO1 = (x, x, D5, D1,...) IO2 = (x, x, D6, D2,...) IO3 = (x, x, D7, D3,...)

7. Security Registers Address:

Security Register1: A23-A16=00H, A15-A12=1H, A11-A10 = 00b, A9-A0= Byte Address; Security Register2: A23-A16=00H, A15-A12=2H, A11-A10 = 00b, A9-A0= Byte Address; Security Register3: A23-A16=00H, A15-A12=3H, A11-A10 = 00b, A9-A0= Byte Address;

8. Dummy bits and Wrap Bits

IO0 = (x, x, x, x, x, x, W4, x) IO1 = (x, x, x, x, x, x, W5, x) IO2 = (x, x, x, x, x, x, W6, x) IO3 = (x, x, x, x, x, x, x, x, x)



- 9. Address, Continuous Read Mode bits, Dummy bits, Manufacture ID and Device ID
  IO0 = (A20, A16, A12, A8, A4, A0, M4, M0, x, x, x, x, MID4, MID0, DID4, DID0, ...)
  IO1 = (A21, A17, A13, A9, A5, A1, M5, M1, x, x, x, x, MID5, MID1, DID5, DID1, ...)
  IO2 = (A22, A18, A14, A10, A6, A2, M6, M2, x, x, x, x, MID6, MID2, DID6, DID2, ...)
  IO3 = (A23, A19, A15, A11, A7, A3, M7, M3, x, x, x, x, MID7, MID3, DID7, DID3, ...)
- 10. QPI Command, Address, Data input/output format:

CLK #0 1 2 3 4 5 6 7 8 9 10 11 IO0= C4, C0, A20, A16, A12, A8, A4, A0, D4, D0, D4, D0 IO1= C5, C1, A21, A17, A13, A9, A5, A1, D5, D1, D5, D1 IO2= C6, C2, A22, A18, A14, A10, A6, A2, D6, D2, D6, D2 IO3= C7, C3, A23, A19, A15, A11, A7, A3, D7, D3, D7, D3

11. A0 must be 0 for Word Read 4xI/O. A0-A3 must be 0 for Octal Word Read.

## Tables of ID Definition:

Operation Code	MID7-MID0	ID15-ID8	ID7-ID0
9FH	B3	60	15
90H/92H/94H	B3		14
ABH			14

#### Table-9 UC25HQ16



#### 9.1 Write Enable (WREN) (06H)

The Write Enable (06H) command sets the Write Enable Latch (WEL) bit. The WEL bit must be set prior to every Page Program, Page Erase, Sector Erase, Half Block Erase, Block Erase, Chip Erase, Write Status Register and Erase/Program Security Register command. The WREN command is entered by driving Chip Select (CS#) Low, sending the command code, and then driving CS# High.

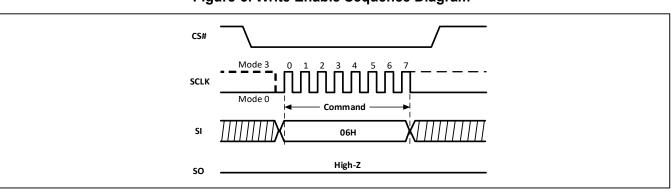
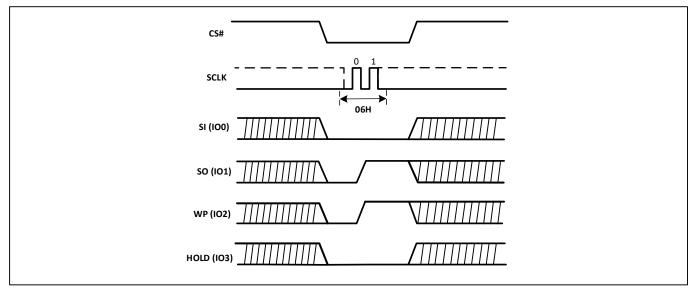


Figure-3. Write Enable Sequence Diagram

Figure-4. Write Enable (WREN) Sequence (QPI)





### 9.2 Write Disable (WRDI) (04H)

The Write Disable (04H) command resets the Write Enable Latch (WEL) bit in the Status Register to 0. The WRDI command is entered by driving Chip Select (CS#) low, shifting the command code "04h" into the SI pin and then driving CS# high. Note that the WEL bit is automatically reset after Power-up and upon completion of the Write Status Register, Page Program, Page Erase, Sector Erase, Half Block Erase, Block Erase, Chip Erase, Erase/Program Security Register and Reset commands.

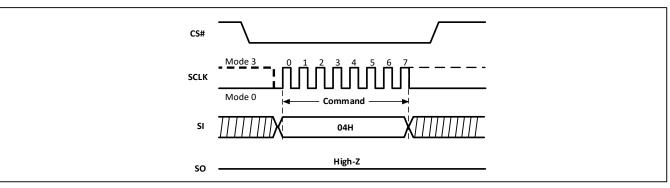
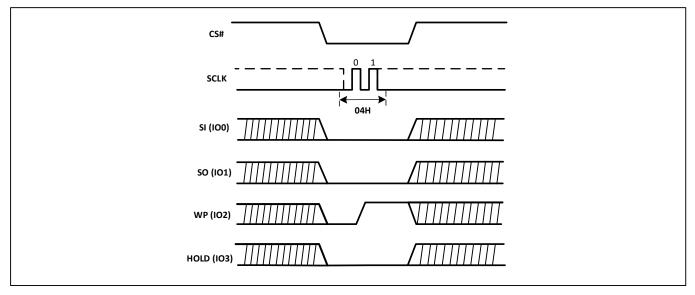


Figure-5. Write Disable Sequence Diagram





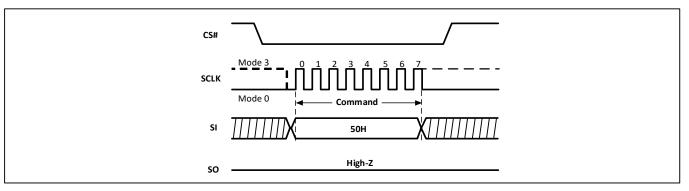


## 9.3 Write Enable for Volatile Status Register (50H)

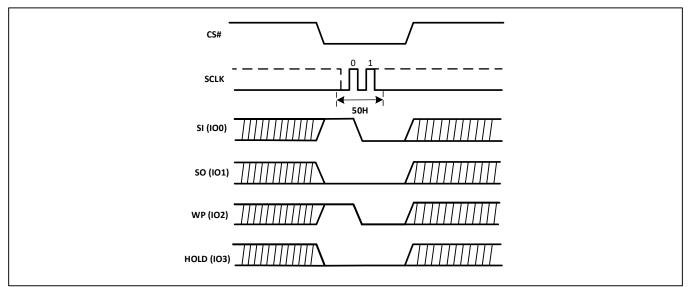
The non-volatile Status Register bits can also be written to as volatile bits. During power up reset, the nonvolatile Status Register bits are copied to a volatile version of the Status Register that is used during device operation. This provides more flexibility to change the system configuration and memory protection schemes quickly without waiting for the typical non-volatile bit write cycles or affecting the endurance of the Status Register non-volatile bits.

To write the volatile version of the Status Register bits, the Write Enable for Volatile Status Register (50H) command must be issued and immediately followed by the Write Status Register (01H/11H/31H) command. Write Enable for Volatile Status Register command (Figure-7) will not set the Write Enable Latch (WEL) bit, it is only valid for the next Write Status Register command, to change the volatile Status Register bit values.





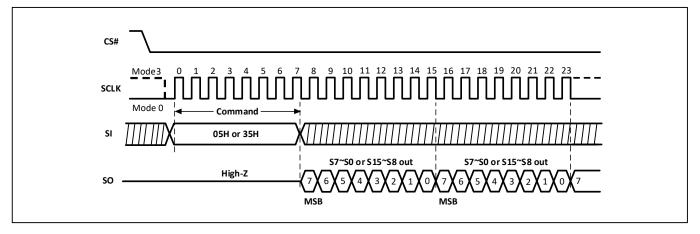




## 9.4 Read Status Register (RDSR) (05H, 35H)

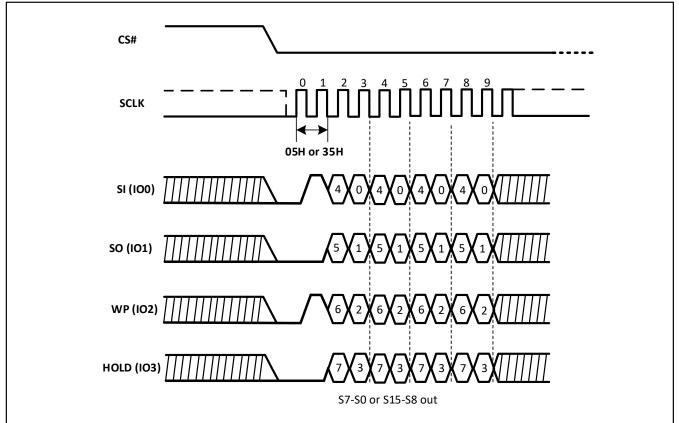
The Read Status Register (05H or 35H) command allows the Status Register to be read. The Status Register may be read at any time, even while a Program, Erase or Write Status Register cycle is in progress. When one of these cycles is in progress, it is recommended to check the Write In Progress (WIP) bit before sending a new command to the device. It is also possible to read the Status Register continuously. For command code "05H", the SO will output Status Register bits S7~S0. And for command code "35H", the SO will output Status Register bits S15~S8.

The sequence of issuing RDSR instruction is: CS# goes low $\rightarrow$  sending RDSR instruction code $\rightarrow$  Status Register data out on SO.



#### Figure-9. Read Status Register Sequence Diagram

Figure-10. Read Status Register Sequence Diagram (QPI)



#### 9.5 Active Status Interrupt (ASI) (25H)

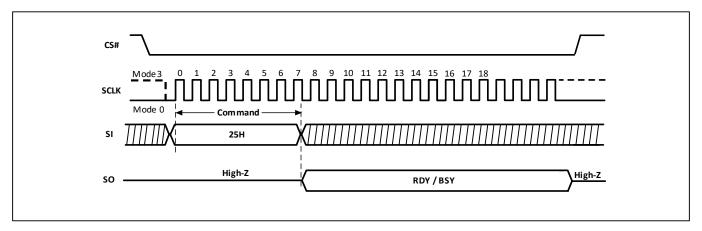
The Active Status Interrupt (25h) command provides an alternative method to read the Write In Progress (WIP) bit. The SO pin outputs the WIP bit continuously with the ASI command. The SO pin can be connected to an interrupt line of the host controller, and the host controller remains in sleep mode until the SO pin indicates that the device is ready for the next command.

The WIP bit can be read at any time, including while an internally self-timed program or erase operation is in progress. To enable the ASI command, the CS# pin must first be asserted and the opcode of 25h must be clocked into the device.

The value of WIP is then output on the SO pin and is continuously updated by the device for as long as the CS# pin remains asserted. Additional clocks on the SCLK pin are not required. If the WIP bit changes from 1 to 0 while the CS# pin is asserted, the SO pin will change from 1 to 0 when the program/erase operation is completed. (The WIP bit cannot change from 0 to 1 during an operation, so if the SO pin already is 0, it will not change.)

Deserting the CS# pin will terminate the ASI operation and put the SO pin into a high-impedance state. The CS# pin can be deserted at any time and does not require that a full byte of data be read.

The sequence of issuing ASI command is: CS# goes low -> send Active Status Interrupt (25H) command code -> Write In Progress (WIP) data out on SO.



#### Figure-11. Active Status Interrupt Sequence Diagram

#### 9.6 Write Status Register (WRSR) (01H or 31H)

WRSR can write 8bits or 16bits data. The Write Status Register (01H for one byte or two bytes, 31H for one byte only) command allows new values to be written to the Status Register. Command 01H is used to write S7~S0 (one byte) or S15~S0(two bytes). Command 31H is used to write S15~S8. Before the command can be accepted, a Write Enable (06H) command must previously have been executed. After the Write Enable command has been decoded and executed, the device sets the Write Enable Latch (WEL).

The WRSR command is entered by driving Chip Select (CS#) Low, followed by the command code and the data byte on Data Input (SI).

The WRSR command has no effect on S15, S10, S1 and S0 of the Status Register. CS# must be driven high after the sixteenth bit or eighth bit of the data byte has been latched in. If not, the WRSR command is not executed. As soon as CS# is driven High, the self-timed Write Status Register cycle (whose duration is tW) is initiated. While the Write Status Register cycle is in progress, the Status Register may still be read to check the value of the Write In Progress (WIP) bit. The WIP bit is 1 during the self-timed Write Status Register cycle and is 0 when it is completed. When the cycle is completed, the WEL bit is reset.

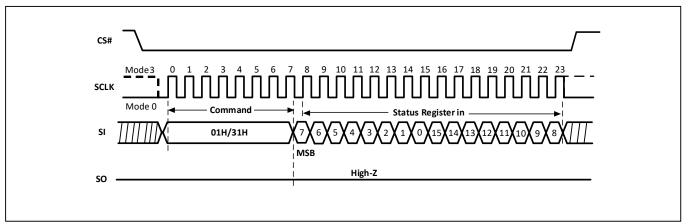
The WRSR command allows the user to change the values of the Block Protect (BP4, BP3, BP2, BP1, 23

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BP0) bits. The WRSR command also allows the user to set or reset the Status Register Protect (SRP1 and SRP0) bits in accordance with the Write Protect (WP#) signal. The Status Register Protect (SRP1 and SRP0) bits and WP# signal allow the device to be put in the Hardware Protection Mode. The WRSR command is not executed once the Hardware Protection Mode is entered.

CS# must go high exactly at the 8bit or 16bit data boundary; otherwise the command will be rejected and not executed. The self-timed Write Status Register cycle time (tW) is initiated as soon as CS# goes high. The WIP bit still can be checked during the Write Status Register cycle is in progress. The WIP is set to 1 during tW and is reset to 0 along with the WEL bit when Write Status Register Cycle is completed.





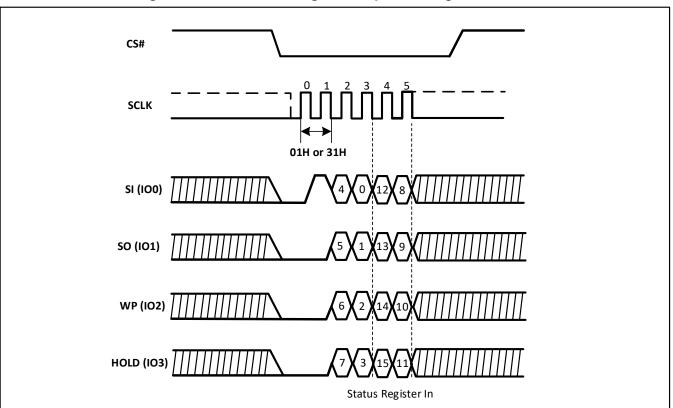


Figure-13. Write Status Register Sequence Diagram (QPI)

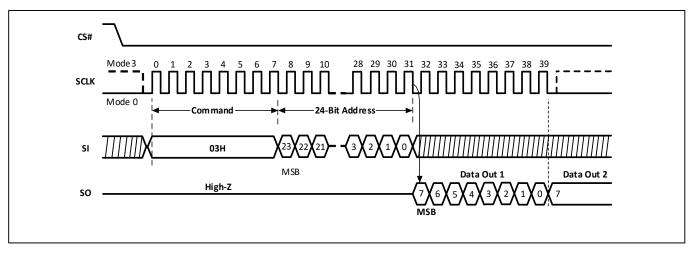


## 9.7 Read Data Bytes (READ) (03H)

The device is first selected by driving Chip Select (CS#) Low. The command code for the Read Data Bytes (03H) command is followed by a 3-byte address (A23-A0), with each bit latched-in on the rising edge of Serial Clock (SCLK). Then the memory contents, at that address, is shifted out on Data Output (SO), with each bit shifted out at a maximum frequency fR on the falling edge of SCLK.

The command sequence is shown in Figure-14. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The whole memory can, therefore, be read with a single READ command. When the highest address is reached, the address counter rolls over to 000000h, allowing the read sequence to be continued indefinitely.

The READ command is terminated by driving CS# High. CS# can be driven High at any time during data output. Any READ command to the memory array, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.



#### Figure-14. Read Data Bytes Sequence Diagram

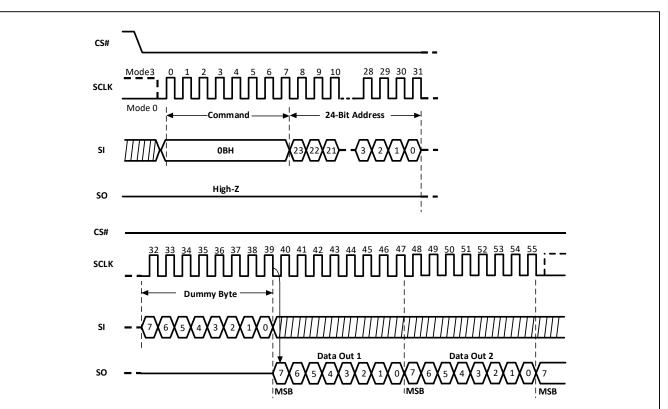
## 9.8 Read Data Bytes at Higher Speed (FAST\_READ) (0BH)

The device is first selected by driving Chip Select (CS#) Low. The command code for the Read Data Bytes at Higher Speed (0BH) command is followed by a 3-byte address (A23-A0) and a dummy byte, each bit being latched-in on the rising edge of Serial Clock (SCLK). Then the memory contents, at that address, is shifted out on Data Output (SO), with each bit shifted out at a maximum frequency fC on the falling edge of SCLK.

The command sequence is shown in Figure-15. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The whole memory can, therefore, be read with a single FAST\_READ command. When the highest address is reached, the address counter rolls over to 000000h, allowing the read sequence to be continued indefinitely.

The FAST\_READ command is terminated by driving CS# High. CS# can be driven High at any time during data output. Any FAST\_READ command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.



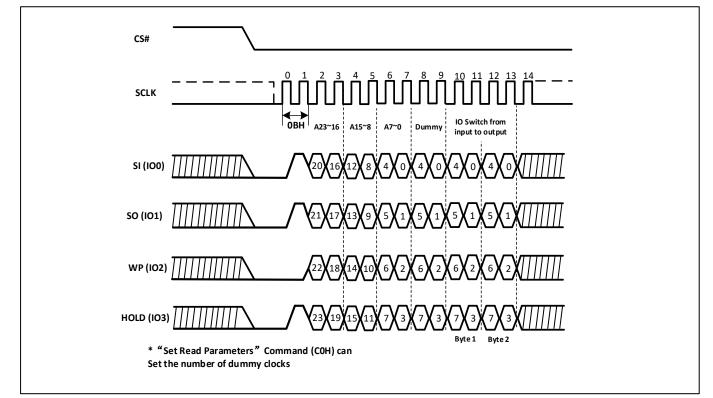


## Figure-15. Read Data Bytes at Higher Speed Sequence Diagram

## Read Data Bytes at Higher Speed in QPI mode

The Fast Read command is also supported in QPI mode. In QPI mode, the number of Dummy Cycles is configured by the "Set Read Parameters (C0H)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of Dummy Cycles can be configured as either 4/6/8.



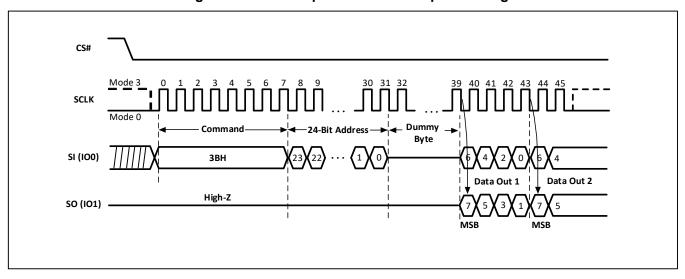




## 9.9 Dual Output Fast Read (DREAD) (3BH)

The Dual Output Fast Read (3BH) is similar to the standard Fast Read (0BH) command except that data is output on two pins, SI (IO0) and SO (IO1), instead of just SO. This allows data to be transferred from the UC25HQxx at twice the rate of standard SPI devices. The DREAD command is ideal for quickly downloading code from the flash to RAM upon power-up or for applications that cache code-segments to RAM for execution.

Like the Fast Read command, the DREAD command can operate at the highest possible frequency of fT. This is accomplished by adding eight "Dummy Cycles after the 24-bit address as shown in Figure-17. The Dummy Cycles allow the device's internal circuits the time required for setting up the initial address. The input data during the Dummy Cycle is "don't care". However, the SI pin should be in a high-impedance state prior to the falling edge of SLCK for the first data out.



#### Figure-17. Dual Output Fast Read Sequence Diagram

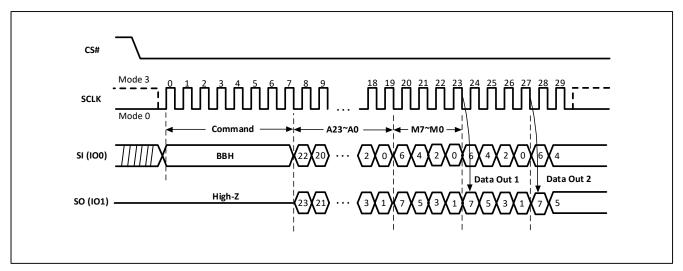
### 9.10 Dual I/O Fast Read (2READ) (BBH)

The Dual I/O Fast Read (BBH) command allows for improved random access while maintaining two IO pins, SI (IO0) and SO (IO1). It is similar to the Dual Output Fast Read (3BH) command but with the ability to input the address bits (A23-0) two bits per clock. This reduced command overhead may allow for code execution (XIP) directly from the Dual SPI in some applications.

The 2READ command enables double throughput of Serial Flash in read mode. The address is latched on rising edge of SCLK, and two bits of data (interleave 2 I/O pins) are shifted out on the falling edge of SCLK at a maximum frequency fT. The first address can be at any location. The address is automatically increased to the next higher address after each byte data is shifted out, so the whole memory can be read out with a single 2READ command. The address counter rolls over to 0 when the highest address has been reached. The 2READ command is shown in Figure-18.





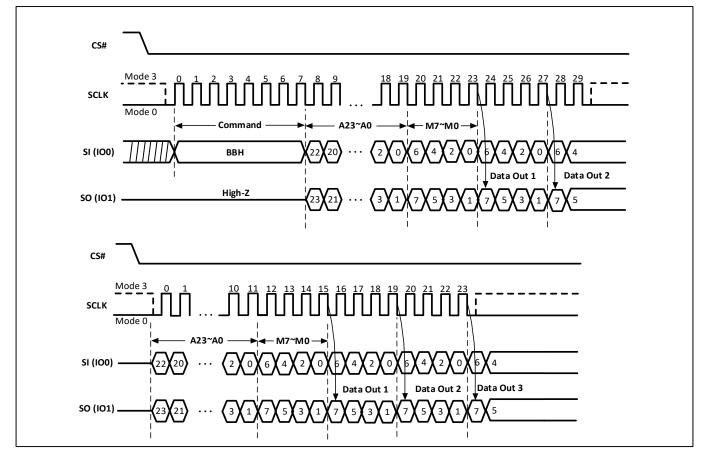


## Dual I/O Fast Read with "Continuous Read Mode" (BBH)

The Dual I/O Fast Read (BBH) command supports Dual I/O Fast Read with "Continuous Read Mode" which can further reduce command overhead by setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5-4) = (1, 0), then the next Dual I/O Fast Read command (after CS# is raised and then lowered) does not require the BBH command code.

If the "Continuous Read Mode" bits (M5-4) do not equal (1, 0), the next command requires the first BBH command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5-4) before issuing a normal command.

Figure-19. Dual I/O Fast Read with "Continuous Read Mode" Sequence Diagram (M5-4 = (1,0))



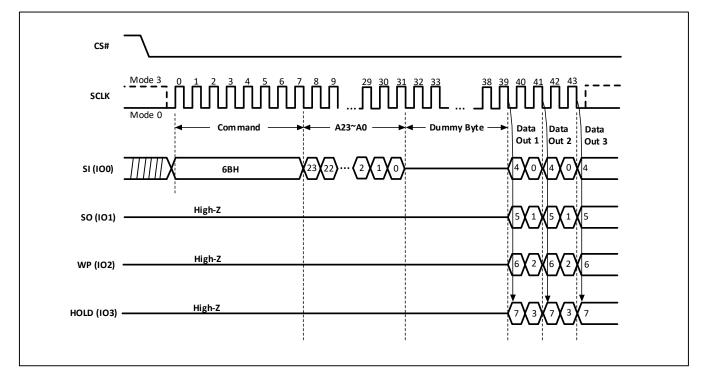


**Note**: Dual I/O Fast Read with "Continuous Read Mode", if (M5-4)=(1,0). If not using "Continuous Read Mode" recommend setting  $(M5-4)\neq(1,0)$ .

## 9.11 Quad Output Fast Read (QREAD) (6BH)

The Quad Output Fast Read (6BH) command is similar to the Dual Output Fast Read (3BH) command except that data is output on four pins, IO0, IO1, IO2, and IO3. A Quad Enable (QE) of Status Register-2 must be executed before the device will accept the QREAD Command. (The QE bit must equal "1"). The QREAD Command allows data to be transferred at four times the rate of standard SPI devices.

The QREAD command can operate at a higher frequency than the traditional Read Data command. This is accomplished by adding eight "dummy" Cycles after the 24-bit address as shown in Figure-20. The Dummy Cycles allow the device's internal circuits the time required for setting up the initial address. The input data during the Dummy Cycles is "don't care." However, the IO pins should be in a high-impedance state prior to the falling edge of SCLK for the first data out.



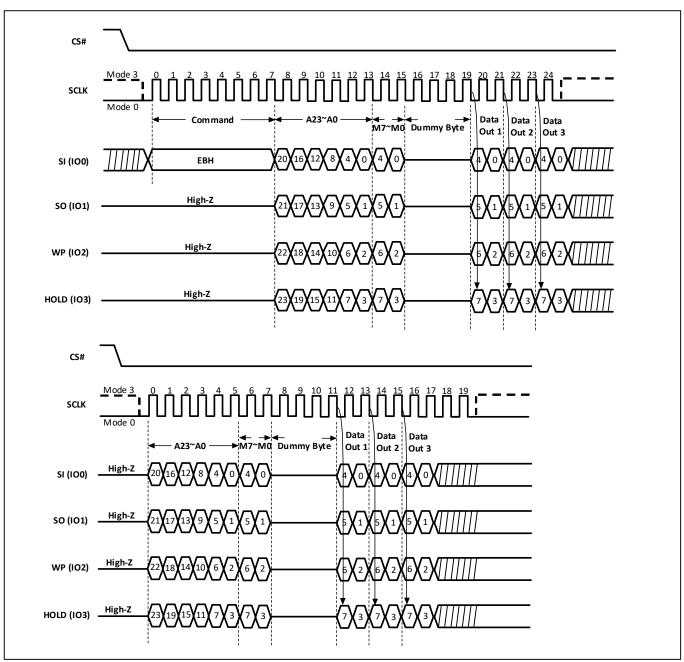
### Figure-20. Quad Output Fast Read Sequence Diagram

### Quad I/O Fast Read with "Continuous Read Mode" (EBH)

The Quad I/O Fast Read (EBH) command supports Quad I/O Fast Read with "Continuous Read Mode" which can further reduce command overhead by setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5-4) = (1, 0), then the next Quad I/O Fast Read (EBH) command (after CS# is raised and then lowered) does not require the EBH command code.

If the "Continuous Read Mode" bits (M5-4) do not equal (1, 0), the next command requires the first EBH command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5-4) before issuing a normal command.





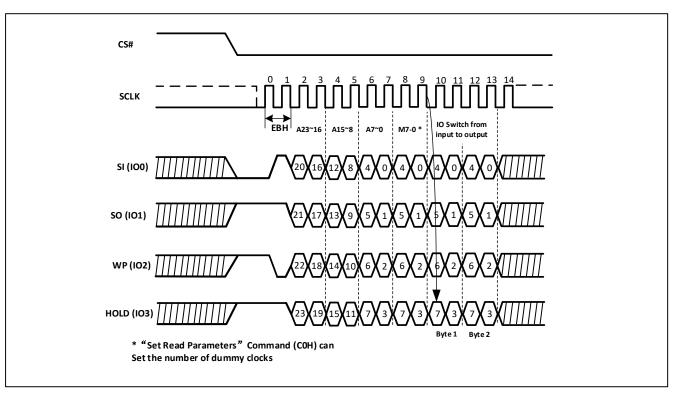
#### Figure-21. Quad I/O Fast Read with "Continuous Read Mode" Sequence Diagram (M5-4 = (1,0))

**Note**: Quad I/O Fast Read with "Continuous Read Mode", if (M5-4)=(1,0). If not using "Continuous Read Mode" recommend setting (M5-4)≠(1,0).

## Quad I/O in QPI mode

The Quad I/O Fast Read command is also supported in QPI mode. In QPI mode, the number of Dummy Cycles is configured by the "Set Read Parameters (C0H)" command to accommodate a wide range application with different needs for either maximum Fast Read frequency or minimum data access latency. Depending on the Read Parameter Bits P[5:4] setting, the number of Dummy Cycles can be configured as either 4/6/8. In QPI mode, the "Continuous Read Mode" bits M7-M0 are also considered as Dummy Cycles. "Continuous Read Mode" feature is also available in QPI mode for Quad I/O Fast Read command. "Wrap Around" feature is not available in QPI mode for Quad I/O Fast Read command. To perform a read operation with fixed data length wrap around in QPI mode, a dedicated "Burst Read with Wrap" (0CH) command must be used.





#### Figure-22. Quad I/O Read in QPI Mode Sequence (M5-4 ≠ (1,0))

## 9.12 Quad I/O Fast Read (4READ) (EBH)

The Quad I/O Fast Read (EBH) command is similar to the Dual I/O Fast Read (BBH) command except that address and data bits are input and output through four pins, SI (IO0), SO (IO1), WP (IO2) and HOLD (IO3). Six Dummy Cycles are required prior to the data output. A Quad Enable (QE) of Status Register-2 must be executed before the device will accept the 4READ Command. (The QE bit must equal "1"). The Quad I/O dramatically reduces command overhead allowing faster random access for code execution (XIP) directly from the Quad SPI.

The 4READ command enables quad throughput of Serial Flash in read mode. The address is latched on rising edge of SCLK, and data four bits of data (interleave on 4 I/O pins) shift out on the falling edge of SCLK at a maximum frequency fQ. The first address can be any location. The address is automatically increased to the next higher address after each byte data is shifted out, so the whole memory can be read out with a single 4READ command. The address counter rolls over to 0 when the highest address has been reached. Once writing 4READ command, the following address / dummy / data out will transfer 4-bits per clock cycle instead of the previous 1-bit.

The sequence of issuing 4READ command is: CS# goes low -> send Quad I/O Fast Read (EBH) command -> 24-bit address interleave on IO3, IO2, IO1 and IO0 -> 2+4 dummy cycles -> data out interleave on IO3, IO2, IO1 and IO0 -> end 4READ operation by driving CS# high at any time during data out, as shown in Figure-23.

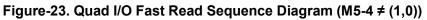
Another sequence of issuing 4READ command especially useful in random access is: CS# goes low -> send Quad I/O Fast Read (EBH) command -> 24-bit address interleave on IO3, IO2, IO1 and IO0 -> "Continuous Read Mode" byte M[7:0] -> 4 dummy cycles -> data out until CS# goes high -> CS# goes low (reduce 4READ command) -> 24-bit random access address.

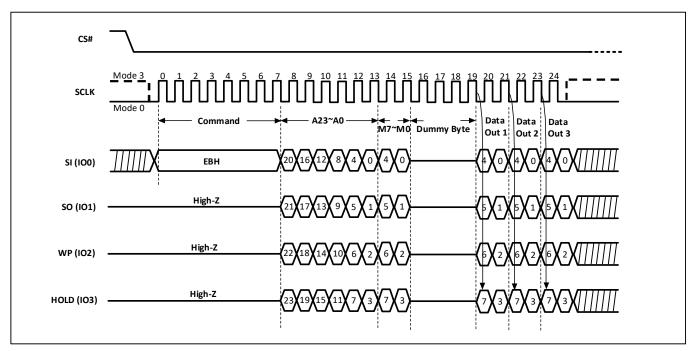
In the Continuous Read Mode, the "Continuous Read Mode" bits M[5:4] = (1,0) can make this mode continue and reduce the next 4READ command. Once  $M[5:4] \neq (1,0)$  and after CS# is raised and then lowered, the system then will escape from the enhanced performance mode and return to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5-4) before issuing normal commands. While Program/Erase/Write Status Register cycle is in progress, the 4READ command is rejected without any impact

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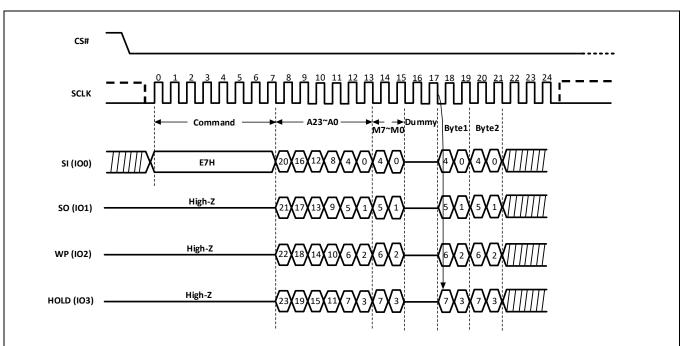
on the Program/Erase/Write Status Register operation.





## 9.13 Quad I/O Word Read (E7H)

The Quad I/O Word Read command is similar to the Quad I/O Read command except that the lowest address bit (A0) must equal 0 and only 2-Dummy Cycle. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The Quad Enable bit (QE) of Status Register (S9) must be set to enable for the Quad I/O Word read command.







## Quad I/O Word Read with "Continuous Read Mode"

The Quad I/O Word Read command can further reduce command overhead through setting the "Continuous Read Mode" bits (M7-0) after the input 3-byte address (A23-A0). If the "Continuous Read Mode" bits (M5-4) = (1, 0), then the next Quad I/O Word Read command (after CS# is raised and then lowered) does not require the E7H command code. If the "Continuous Read Mode" bits (M5-4) do not equal to (1, 0), the next command requires the first E7H command code, thus returning to normal operation. A "Continuous Read Mode" Reset command can be used to reset (M5-4) before issuing normal command.

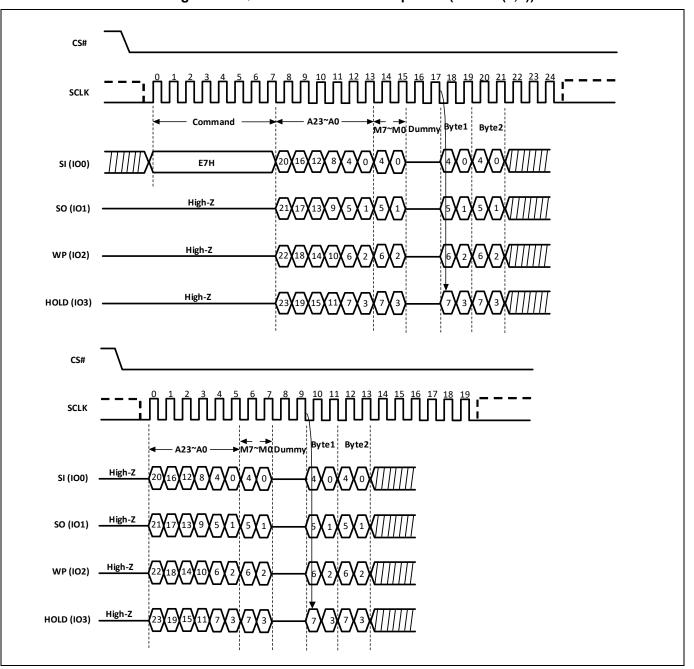


Figure-25. Quad I/O Word Read Sequence (M5-4 = (1,0))

## Quad I/O Word Read with "8/16/32/64-Byte Wrap Around" in Standard SPI mode

The Quad I/O Word Read command can be used to access a specific portion within a page by issuing "Set Burst with Wrap" (77H) commands prior to E7H. The "Set Burst with Wrap" (77H) command can either enable or disable the "Wrap Around" feature for the following E7H commands. When "Wrap Around" is enabled, the data being accessed can be limited to either an8/16/32/64-byte section of a 256-byte page. The output data starts at the initial address specified in the command, once it reaches the ending boundary of the 8/16/32/64-byte section, the output will wrap around the beginning boundary automatically until CS# is pulled high to terminate the command.

The Burst with Wrap feature allows applications that use cache to quickly fetch a critical address and then fill the cache afterwards within a fixed length (8/16/32/64-byte) of data without issuing multiple read commands. The "Set Burst with Wrap" command allows three "Wrap Bits" W6-W4 to be set. The W4 bit is used to enable or disable the "Wrap Around" operation while W6-W5 is used to specify the length of the wrap around section within a page.

## 9.14 Quad I/O Octal Word Read (E3H)

The Quad IO Octal Word Read (E3h) instruction is similar to the Quad IO Read (EBH) instruction except that the lower four Address bits (A0, A1, A2, A3) must equal 0. As a result, the Dummy Cycles are not required, which further reduces the instruction overhead allowing even faster random access for code execution (XIP). The Quad Enable bit (QE) of Status Register-2 must be set to enable the Octal Word Read Quad I/O Instruction.

## Quad IO Octal Word Read with "Continuous Read Mode"

The Quad IO Octal Word Read instruction can further reduce instruction overhead through setting the "Continuous Read Mode" bits (M7-0) after the input Address bits (A23-0). The upper nibble of the (M7-4) controls the length of the next Octal Word Read Quad I/O instruction through the inclusion or exclusion of the first byte instruction code. The lower nibble bits of the (M3-0) are don't care ("x"). However, the IO pins should be high-impedance prior to the falling edge of the first data out clock.

If the "Continuous Read Mode" bits M5-4 = (1,0), then the next Fast Read Quad I/O instruction (after CS# is raised and then lowered) does not require the E3h instruction code, as shown in Figure 26. This reduces the instruction sequence by eight clocks and allows the Read address to be immediately entered after CS# is asserted low. If the "Continuous Read Mode" bits M5-4 do not equal to (1,0), the next instruction (after CS# is raised and then lowered) requires the first byte instruction code, thus returning to normal operation. It is recommended to input FFH on IO0 for the next instruction (8 clocks), to ensure M4 = 1 and return the device to normal operation.



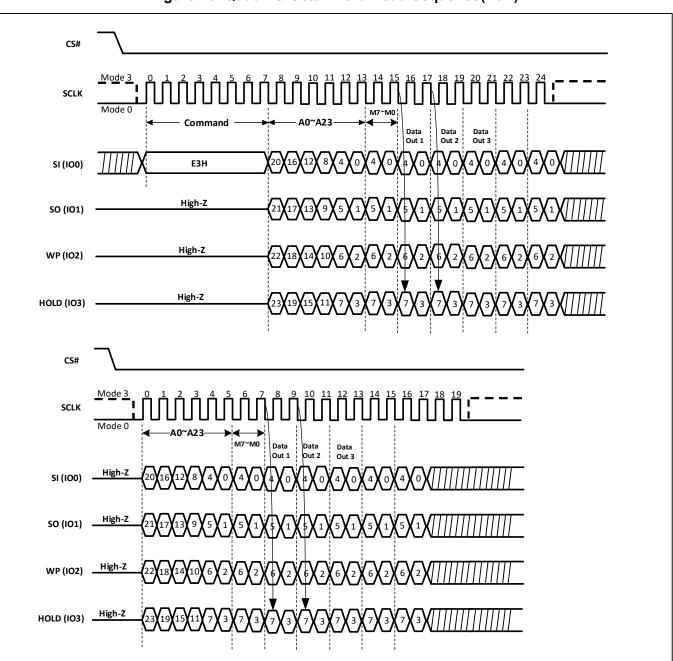


Figure 26. Quad I/O Octal Word Read Sequence(E3H)

## 9.15 Set Read Parameters (C0H)

In QPI mode the "Set Read Parameters (C0H)" command can be used to configure the number of Dummy Cycles for "Fast Read (0BH)", "Quad I/O Fast Read (EBH)", "Read Security Register (48H)", "Read SFDP Mode (5AH)"and "Burst Read with Wrap (0CH)" command, and to configure the number of bytes of "Wrap Length" for the "Burst Read with Wrap (0CH)" command. The "Wrap Length" is set by W5-6 bit in the "Set Burst with Wrap (77H)" command. This setting will remain unchanged when the device is switched from Standard SPI mode to QPI mode.

P5-P4	Dummy Cycles	Maximum Read Freq.	P1-P0	Wrap Length
0,0	10	85MHz	0,0	8-byte
0,1	4	66MHz	0,1	16-byte
1,0	6	66MHz	1,0	32-byte
1,1	8	85MHz	1,1	64-byte



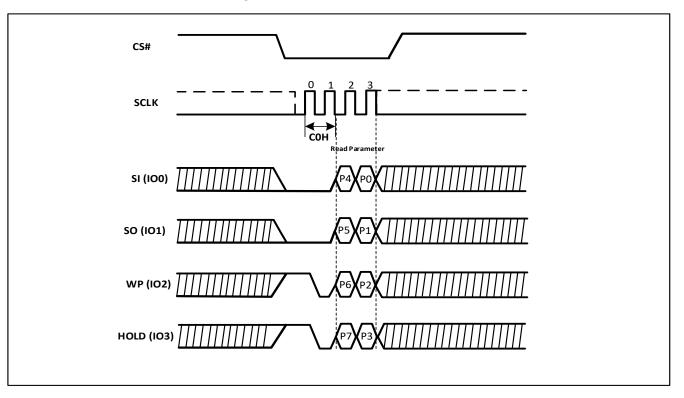
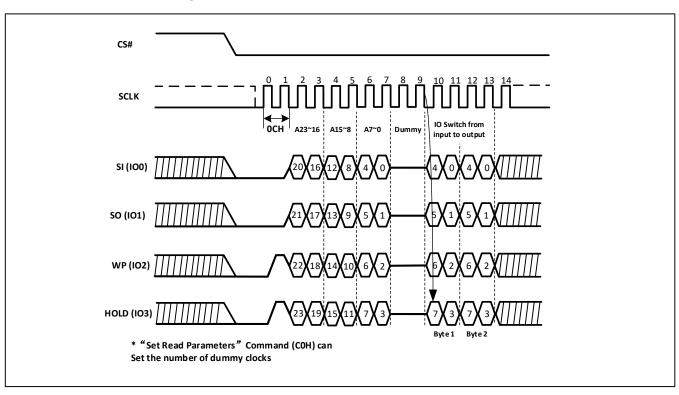


Figure 27. Set Read Parameters (QPI)

### 9.16 Burst Read with Wrap (0CH)

The "Burst Read with Wrap (0CH)" command provides an alternative way to perform the read operation with "Wrap Around" in QPI mode. This command is similar to the "Fast Read (0BH)" command in QPI mode, except the addressing of the read operation will "Wrap Around" to the beginning boundary of the "Wrap Around" once the ending boundary is reached. The "Wrap Length" and the number of Dummy Cycles can be configured by the "Set Read Parameters (C0H)" command.





## Figure 28. Burst Read with Wrap Sequence (QPI)

## 9.17 Set Burst with Wrap (77H)

The Set Burst with Wrap (77h) command is used in conjunction with Quad I/O Fast Read (EBH/E7H) command to access a fixed length of 8/16/32/64-byte section within a 256-byte page, in standard SPI mode.

The Set Burst with Wrap command sequence: CS# goes low -> Send Set Burst with Wrap (77h) command -> Send 24 dummy bits-> Send 8 bits "Wrap bits" -> CS# goes high.

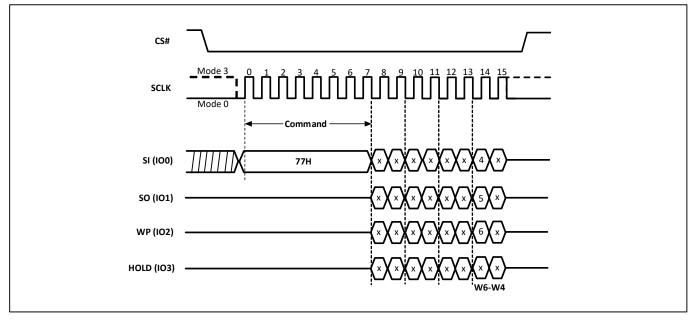
If the W6-W4 bits are set by the Set Burst with Wrap command, all the following Quad I/O Fast Read commands will use the W6-W4 setting to access the 8/16/32/64-byte section within any page. To exit the "Wrap Around" function and return to normal read operation, another Set Burst with Wrap command should be issued to set W4=1.

	<b>0</b> 1				
	W4	W4=0 W4=1 (d		default)	
W6,W5	Wrap	Wrap	Wrap	Wrap	
	Around	Length Around		Length	
0,0	Yes	8-byte	No	N/A	
0,1	Yes	16-byte	No	N/A	
1,0	Yes	32-byte	No	N/A	
1,1	Yes	64-byte	No	N/A	

Table-10.	Burst	Lenath	and	Wrap
	Builde	Longui	ana	TTUP







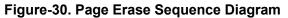
### 9.18 Page Erase (PE) (81H)

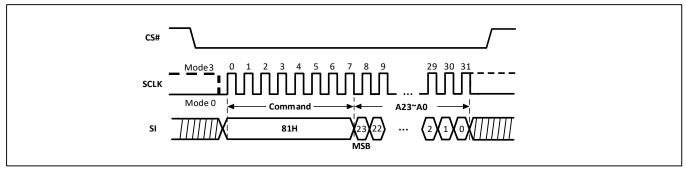
The Page Erase (81H) command sets all bits to 1 (FFH) inside the chosen page. Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable command has been decoded, the device sets the Write Enable Latch (WEL).

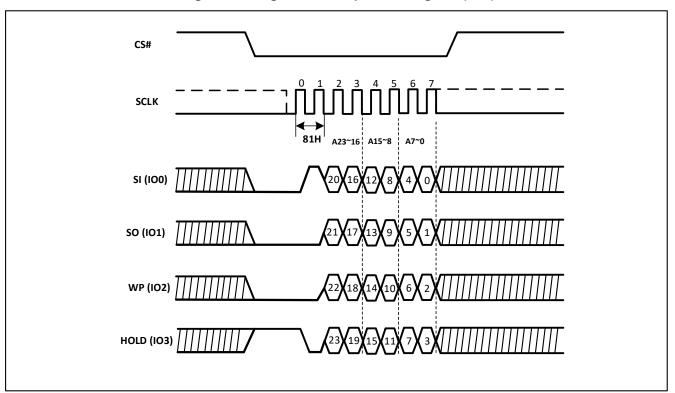
The PE command is entered by driving Chip Select (CS#) Low, followed by the command code, and three address bytes on Data Input (SI). Any address inside the page is a valid address for the PE command. CS# must be driven Low for the entire duration of the sequence.

The command sequence is shown in Figure-30. The CS# must go high exactly at the byte boundary (after the least significant bit of the third address byte is latched-in); otherwise, the command will be rejected and not executed. As soon as CS# is driven High, the self-timed Page Erase cycle (with duration tPE) is initiated. While the Page Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The WIP bit is 1 during the self-timed Page Erase cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

A PE command may be applied only to a page which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.







### Figure-31. Page Erase Sequence Diagram (QPI)

## 9.19 Sector Erase (SE) (20H)

The Sector Erase (20H) command sets all bits to 1 (FFH) inside the chosen sector. Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable command has been decoded, the device sets the Write Enable Latch (WEL).

The SE command is entered by driving Chip Select (CS#) Low, followed by the command code, and three address bytes on Data Input (SI). Any address inside the sector is a valid address for the SE command. CS# must be driven Low for the entire duration of the sequence.

The command sequence is shown in Figure-32. The CS# must go high exactly at the byte boundary (after the least significant bit of the third address byte is latched-in); otherwise, the command will be rejected and not executed. As soon as CS# is driven High, the self-timed Sector Erase cycle (with duration tSE) is initiated. While the Sector Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The WIP bit is 1 during the self-timed Sector Erase cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

A SE command may be applied only to a sector which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.

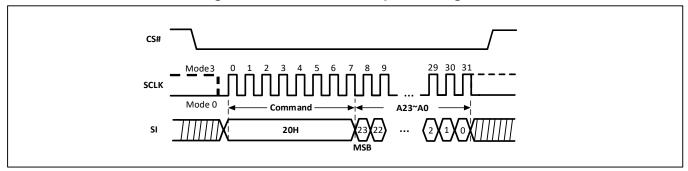


Figure-32. Sector Erase Sequence Diagram



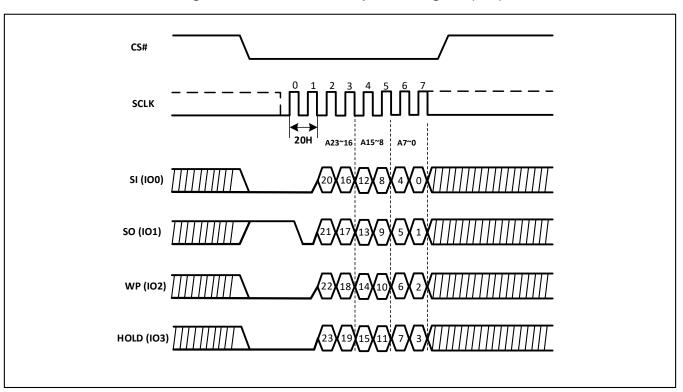


Figure-33. Sector Erase Sequence Diagram (QPI)

The self-timed Sector Erase Cycle time (tSE) is initiated as soon as Chip Select (CS#) goes high. The Write in progress (WIP) bit still can be check out during the Sector Erase cycle is in progress. The WIP sets 1 during the tSE timing, and sets 0 when Sector Erase Cycle is completed, and the Write Enable Latch (WEL) bit is reset. If the sector is protected by BP4, BP3, BP2, BP1, BP0 bits, the Sector Erase (SE) instruction will not be executed on the sector

# 9.20 Half Block Erase (HBE) (52H)

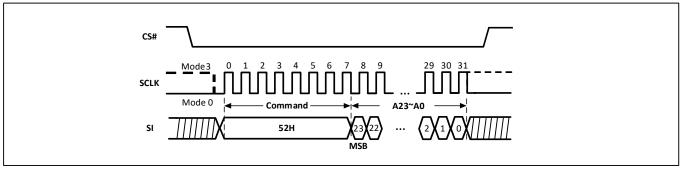
The Half Block Erase (52H) command sets all bits to 1 (FFH) inside the chosen block. Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable command has been decoded, the device sets the Write Enable Latch (WEL).

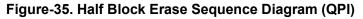
The HBE command is entered by driving Chip Select (CS#) Low, followed by the command code, and three address bytes on Data Input (SI). Any address inside the block is a valid address for the HBE command. CS# must be driven Low for the entire duration of the sequence.

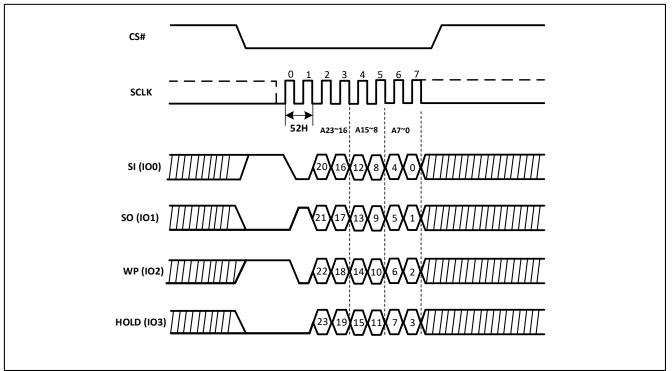
The command sequence is shown in Figure-34. The CS# must go high exactly at the byte boundary (after the least significant bit of the third address byte is latched-in); otherwise, the command will be rejected and not executed. As soon as CS# is driven High, the self-timed Half Block Erase cycle (with duration tBE1) is initiated. While the Half Block Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The WIP bit is 1 during the self-timed Block Erase cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

A HBE command may be applied only to a half block which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.









# 9.21 Block Erase (BE) (D8H)

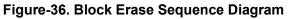
The Block Erase (D8H) command sets all bits to 1 (FFH) inside the chosen block. Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable 06H command has been decoded, the device sets the Write Enable Latch (WEL).

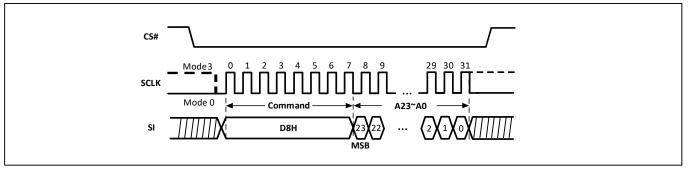
The BE command is entered by driving Chip Select (CS#) Low, followed by the command code, and three address bytes on Data Input (SI). Any address inside the block is a valid address for the BE command. CS# must be driven Low for the entire duration of the sequence.

The command sequence is shown in Figure-36. CS# must be driven High after the least significant bit of the third address byte is latched in, otherwise the BE command is not executed. As soon as CS# is driven High, the self-timed Block Erase cycle (whose duration is tBE2) is initiated. While the Block Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The WIP bit is 1 during the self-timed Block Erase cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

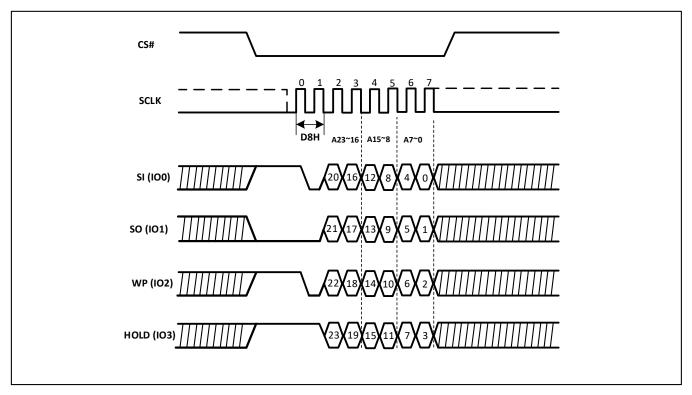
A BE command may be applied only to a block which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.

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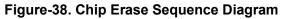
# 9.22 Chip Erase (CE) (60H or C7H)

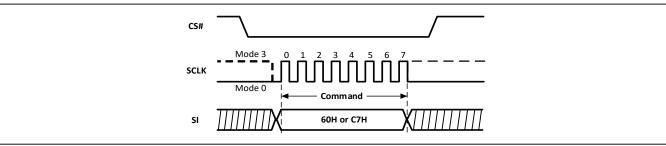
The Chip Erase (60H or C7H) command sets all bits to 1 (FFH). Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable command has been decoded, the device sets the Write Enable Latch (WEL).

The CE command is entered by driving Chip Select (CS#) Low, followed by the command code on Data Input (SI). CS# must be driven Low for the entire duration of the sequence.

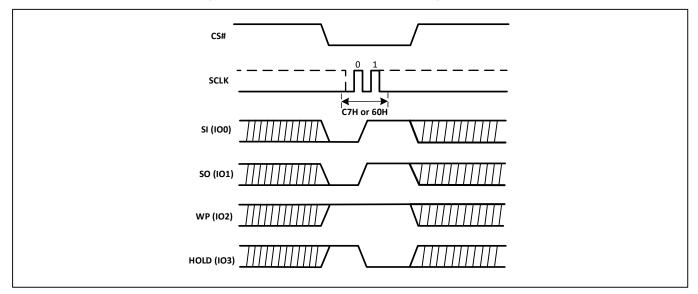
The command sequence is shown in Figure-38. CS# must be driven High after the eighth bit of the command code is latched in, otherwise the CE command is not executed. As soon as CS# is driven High, the self-timed Chip Erase cycle (with duration tCE) is initiated. While the Chip Erase cycle is in progress, the Status Register may be read to check the value of the Write In Progress (WIP) bit. The WIP bit is 1 during the self-timed Chip Erase cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

The CE command is executed only if all Block Protect (BP4, BP3, BP2, BP1, BP0) bits are 0. The CE command is ignored if one, or more blocks are protected.





### Figure-39. Chip Erase Sequence Diagram (QPI)



### 9.23 Page Program (PP) (02H)

The Page Program (02H) command allows bytes to be programmed in the memory. Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable command has been decoded, the device sets the Write Enable Latch (WEL).

The PP command is entered by driving Chip Select (CS#) Low, followed by the command code, three address bytes and at least one data byte on Data Input (SI). If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are programmed from the starting address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven Low for the entire duration of the sequence.

The command sequence is shown in Figure-40. If more than 256 bytes are sent to the device, previously latched data are discarded, and the last 256 data bytes are guaranteed to be programmed correctly within the same page. If less than 256 Data bytes are sent to device, they are correctly programmed at the requested addresses without having any effects on the other bytes of the same page.

CS# must be driven High after the eighth bit of the last data byte has been latched in, otherwise the PP command is not executed.

As soon as CS# is driven High, the self-timed Page Program cycle (with duration tPP) is initiated. While the Page Program cycle is in progress, the Status Register may be read to check the value of the WIP bit. The WIP bit is 1 during the self-timed Page Program cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

A PP command may be applied only to a page which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.





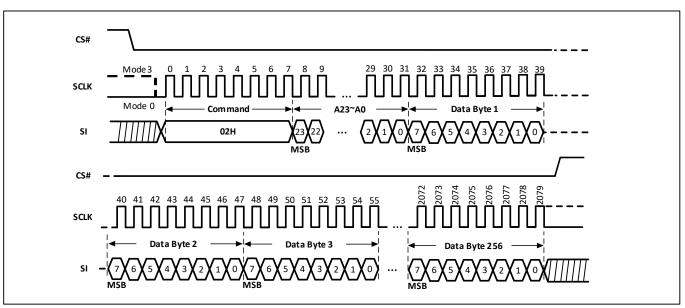
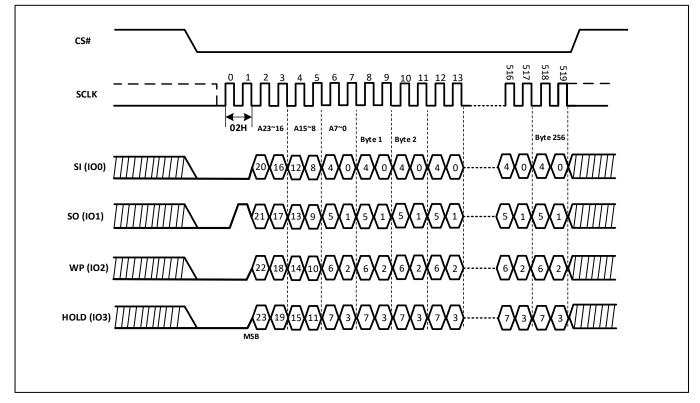


Figure-41. Page Program Sequence Diagram (QPI)



# 9.24 Page Write (PW) (A5H)

The Page Write (A5H) command is bytes-alterable and allows bytes of data zeros and data ones to be written directly into the memory without issue any erase commands. Before it can be accepted, a Write Enable (06H) command must have previously been executed. After the Write Enable command has been decoded, the device sets the Write Enable Latch (WEL).

The PW command is entered by driving Chip Select (CS#) Low, followed by the command code, three address bytes and at least one data byte on Data Input (SI). If the 8 least significant address bits (A7-A0) are not all zero, all transmitted data that goes beyond the end of the current page are written from the starting address of the same page (from the address whose 8 least significant bits (A7-A0) are all zero). CS# must be driven Low for the entire duration of the sequence.

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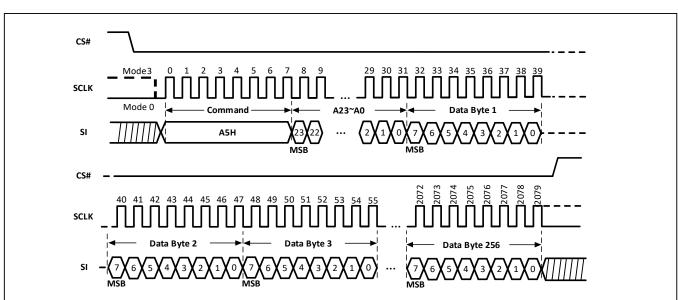


The command sequence is shown in Figure-42. If more than 256 bytes are sent to the device, previously latched data are discarded, and the last 256 data bytes are guaranteed to be written correctly within the same page. If less than 256 Data bytes are sent to device, they are correctly written at the requested addresses without having any effects on the other bytes of the same page.

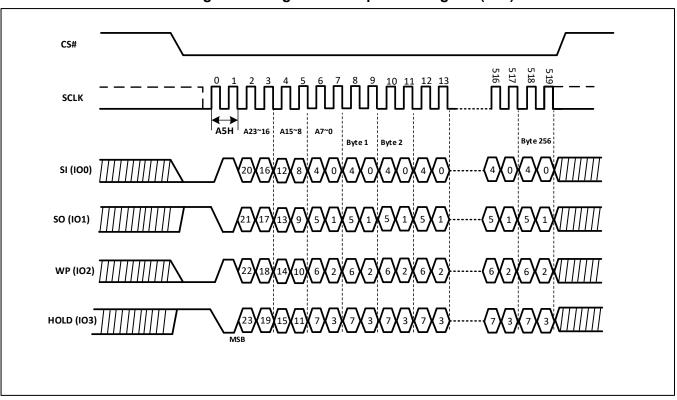
CS# must be driven High after the eighth bit of the last data byte has been latched in, otherwise the PW command is not executed.

As soon as CS# is driven High, the self-timed Page Write cycle (with duration tPW) is initiated. While the Page Write cycle is in progress, the Status Register may be read to check the value of the WIP bit. The WIP bit is 1 during the self-timed Page Write cycle and is 0 when it is completed. At some unspecified time before the cycle is completed, the WEL bit is reset.

A PW command may be applied only to a page which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.



### Figure-42. Page Write Sequence Diagram



### Figure-43. Page Write Sequence Diagram (QPI)

# 9.25 Dual Input Page Program (DPP) (A2H)

The Dual Input Page Program (A2H) command is similar to the standard Page Program command and can be used to program anywhere from a single byte of data up to 256 bytes of data into previously erased memory locations. The DPP command allows two bits of data to be clocked into the device on every clock cycle rather than just one.

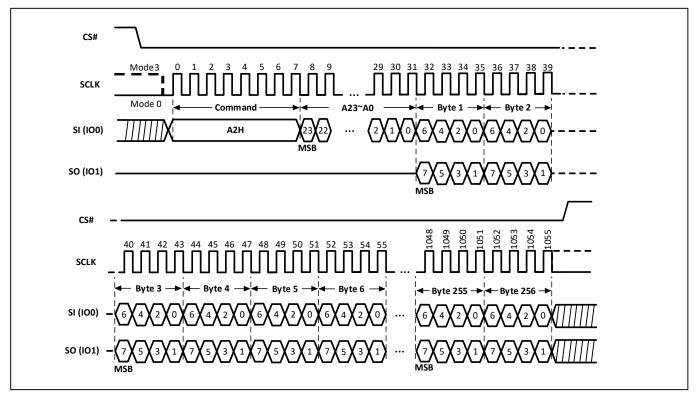
A Write Enable (06H) command must be executed to set the Write Enable Latch (WEL) bit before sending the DPP command. The Dual Input Page Programming takes two pins: IO0, IO1 as data input, which can improve programmer as well as in-system application performance. The other function descriptions are as same as the standard page program.

The sequence of issuing DPP command is: CS# goes low -> send Dual Input Page Program (A2H) command code -> 3-byte address on SI -> at least 1-byte on data on IO[1:0] -> CS# goes high.

A DPP command may be applied only to a page which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.







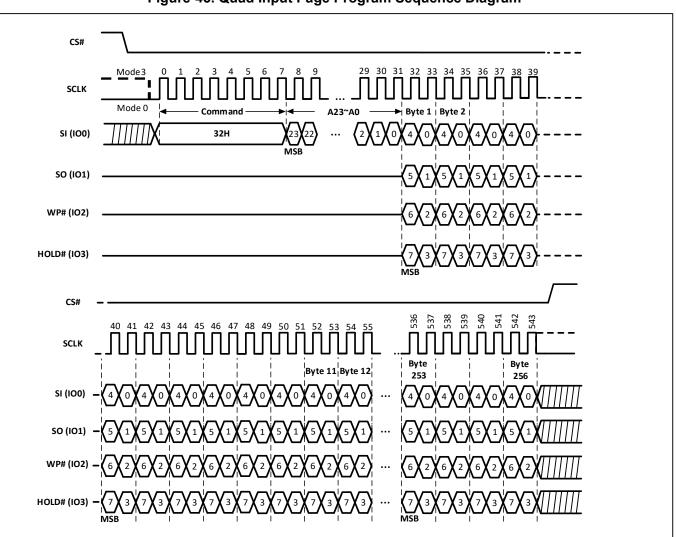
## 9.26 Quad Input Page Program (QPP) (32H)

The Quad Input Page Program (32H) command is for programming the memory to be "0". A Write Enable command must be executed to set the Write Enable Latch (WEL) bit and Quad Enable (QE) bit to "1" before sending the QPP command. The Quad Input Page Programming uses four pins: IO0, IO1, IO2, and IO3 as data input, which can improve programmer as well as in-system application performance. The QPP operation supports frequencies as fast as fQPP. The other function descriptions are as same as standard page program.

The sequence of issuing QPP command is: CS# goes low -> send Quad Input Page Program (32H) command code -> 3-byte address on IO0 -> at least 1-byte on data on IO[3:0] -> CS# goes high.

A QPP command may be applied only to a page which is not protected by the Block Protect (BP4, BP3, BP2, BP1, BP0) bits.





### Figure-45. Quad Input Page Program Sequence Diagram

### 9.27 Erase Security Register (ERSCUR) (44H)

There are three 1024-byte Security Registers which can be erased and programmed individually. These registers may be used by system manufacturers to store security and other important information separately from the main memory array.

The Erase Security Register (44H) command is like the Sector Erase (20H) command. A Write Enable command must be executed before the device will accept the ERSCUR Command (Status Register bit WEL must equal 1). The command is initiated by driving the CS# pin low and shifting the command code "44H" followed by a 24-bit address (A23-A0) to erase one of the security registers.

The ERSCUR command sequence is shown in Figure-46. The CS# pin must be driven high after the eighth bit of the last address byte is latched. If this is not done, the command will not be executed. After CS# is driven high, the self-timed ERSCUR operation will commence for a time duration of tSE.

While the Erase Security Register cycle is in progress, the Read Status Register command (05H) may still be accessed for checking the value of the Write in Progress (WIP) bit. The WIP bit is a 1 during the erase cycle and becomes a 0 when the cycle is finished and the device is ready to accept other commands again. After the Erase Security Register cycle has finished, the WEL bit in the Status Register is cleared to 0. The Security Register Lock Bits (LB3-1) in the Status Register are OTP and can be used to protect the security registers. Once the LB bit is set to 1, the corresponding security register will be permanently locked, and an ERSCUR command to that register will be ignored.

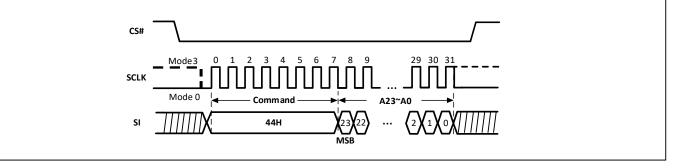
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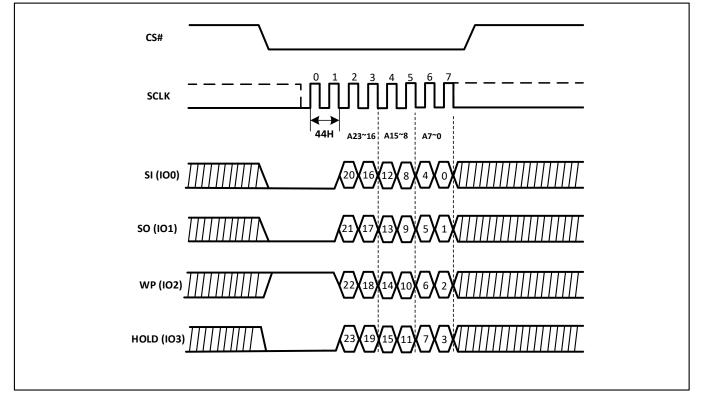
Table-11.1 Erase Security Register Address					
ADDRESS	A23-16	A15-12	A11-10	A9-0	
Security Register #1	00h	0001	00	Don't care	
Security Register #2	00h	0010	00	Don't care	
Security Register #3	00h	0011	00	Don't care	

Table-11.1 Erase Security Register Address





# Figure-47. Erase Security Register Sequence Diagram (QPI)



# 9.28 Program Security Register (PRSCUR) (42H)

The Program Security Register (42H) command is similar to the Page Program (02H) command. It allows from one byte to 1024 bytes of security register data to be programmed at previously erased (FFh) memory locations. A Write Enable (06H) command must be executed before the device will accept the PRSCUR Command (Status Register bit WEL= 1). The command is initiated by driving the CS# pin low then shifting the command code "42H" followed by a 24-bit address (A23-A0) and at least one data byte, into the SI pin. The CS# pin must be held low for the entire length of the command while data is being sent to the device.

The PRSCUR command sequence is shown in Figure-48. The Security Register Lock Bits (LB3-1) in the

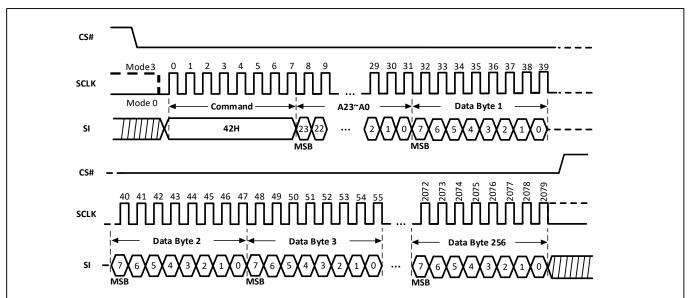


Status Register are OTP can be used to protect the security registers. Once Security Register Lock Bit (LB3-1) is set to 1, the corresponding security register will be permanently locked, and a PRSCUR command to that register will be ignored.

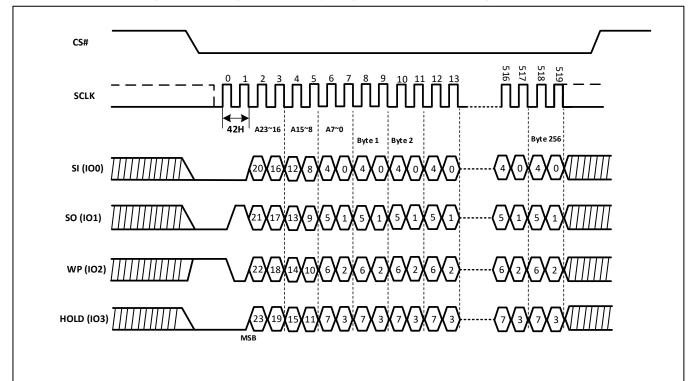
ADDRESS	A23-16	A15-12	A11-10	A9-0	
Security Register #1	00h	0001	00	Byte Address	
Security Register #2	00h	0010	00	Byte Address	
Security Register #3	00h	0011	00	Byte Address	

# Table-11.2 Program Security Register Address





# Figure-49. Program Security Register Sequence Diagram(QPI)



## 9.29 Read Security Register (RDSCUR) (48H)

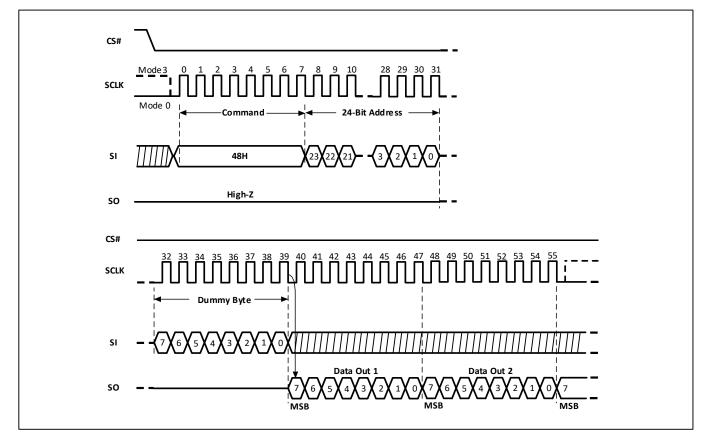
The Read Security Register (48H) command is similar to the Fast Read (0BH) command and allows one or more data bytes to be sequentially read from one of the three security registers. The command is initiated by driving the CS# pin low and then shifting the command code "48H" followed by a 24-bit address (A23-A0) and eight "dummy" Cycles into the SI pin. The code and address bits are latched on the rising edge of the SCLK pin. After the address is received, and following the eight dummy cycles, the data byte of the addressed memory location will be shifted out on the SO pin on the falling edge of SCLK with the most significant bit (MSB) first. The first byte addressed can be at any location. The byte address is automatically incremented to the next byte address after each byte of data is shifted out. Once the byte address reaches the last byte of the register (byte 3FFh), it will reset to 000h, the first byte of the register, and continue to increment. The command is completed by driving CS# high.

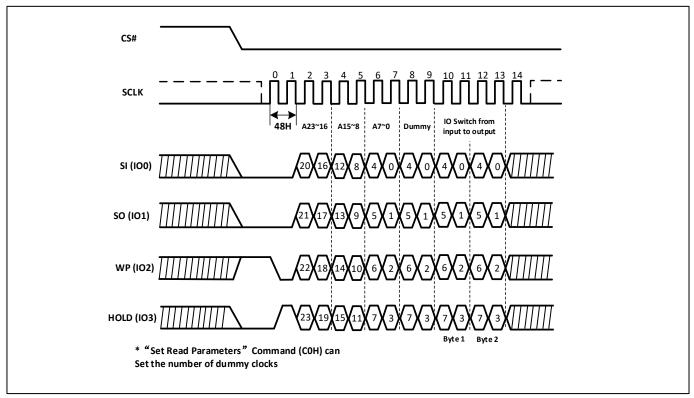
The RDSCUR command sequence is shown in Figure-50. If a RDSCUR command is issued while an Erase, Program, or Write cycle is in process (Write in Progress (WIP)=1), the command is ignored and will not have any effect on the current cycle. The RDSCUR command allows each bit being shifted out on SO pin at a Max frequency fC, on the falling edge of SCLK.

ADDRESS	A23-16	A15-12	A11-10	A9-0
Security Register #1	00h	0001	00	Byte Address
Security Register #2	00h	0010	00	Byte Address
Security Register #3	00h	0011	00	Byte Address

Table-11.3 Read	Security	Register	Address
10010-11.0 11000	Occurry	INCHISICI	Audicaa







### Figure-51. Read Security Register Sequence Diagram (QPI)

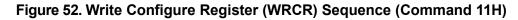
# 9.30 Write Configure Register (WRCR)(11H)

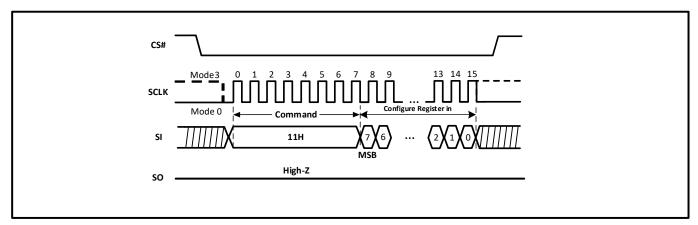
The Write Configure Register (WRCR) command allows new values to be written to the Configure Register. Before it can be accepted, a Write Enable (WREN) command must previously have been executed. After the Write Enable (WREN) command has been decoded and executed, the device sets the Write Enable Latch (WEL).

The sequence of issuing WRCR instruction is: CS# goes low $\rightarrow$  sending WRCR instruction code $\rightarrow$  Configure Register data on SI $\rightarrow$ CS# goes high.

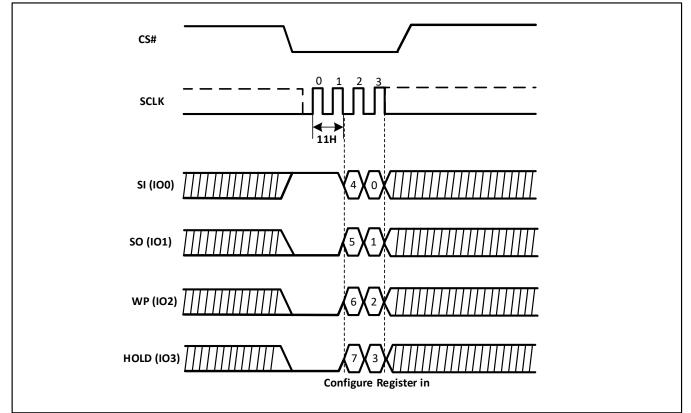
The CS# must go high exactly at the 8 bits data boundary; otherwise, the instruction will be rejected and not executed. The self-timed Write Status Register cycle time (tW) is initiated as soon as Chip Select (CS#) goes high. The Write in Progress (WIP) bit still can be checked during the Write Status Register cycle is in progress. The WIP sets 1 during the tW timing, and sets 0 when Write Configure Register Cycle is completed, and the Write Enable Latch (WEL) bit is reset.











# 9.31 Read Configure Register (RDCR) (45H or 15H in SPI Mode)

The RDCR instruction is for reading Configure Register Bits. The Read Configure Register can be read at any time (even in program/erase/write status register condition). It is recommended to check the Write in Progress (WIP) bit before sending a new instruction when a program, erase, or write status register operation is in progress. The Command code "15H"only support RDCR in SPI Mode.

The sequence of issuing RDCR instruction is: CS# goes low $\rightarrow$  sending RDCR instruction code $\rightarrow$  Configure Register data out on SO.





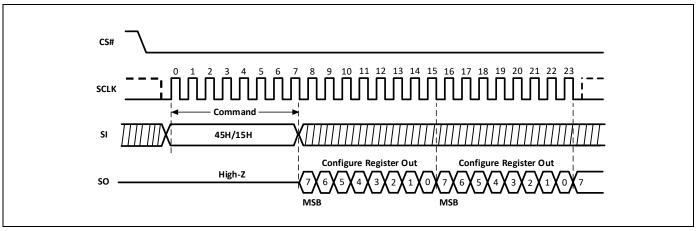
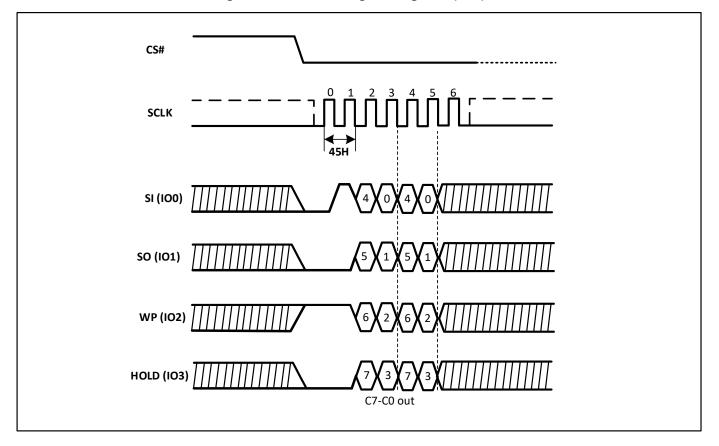


Figure-55. Read Configure Register (QPI)





### 9.32 Deep Power-Down (DP) (B9H)

Executing the Deep Power-Down (B9H) command is the only way to place the device in the lowest power consumption mode (the Deep Power-Down mode). It can also be used as an extra software protection mechanisms the device is not in active use, all Write, Program and Erase commands are ignored.

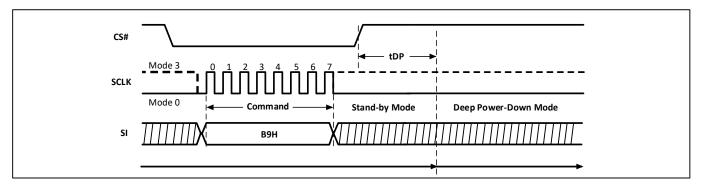
Driving Chip Select (CS#) High deselects the device and puts the device in the Standby mode (if there is no internal cycle currently in progress). However, Standby mode is not the Deep Power-Down mode. The Deep Power-Down mode can only be entered by executing the DP command, to reduce the standby current (from ISB1 to ISB2).

Once the device has entered the Deep Power-Down mode, all commands are ignored except the Release from Deep Power-Down, Read Electronic Signature (ABH) command. This command releases the device from this mode and also outputs the Device ID on Data Output (SO).

The Deep Power-Down mode automatically stops at Power-Down, and the device always Powers-up in the Standby mode. The DP command is entered by driving CS# Low, followed by the command code on Data Input (SI). CS# must be driven Low for the entire duration of the sequence.

The command sequence is shown in Figure-56. CS# must be driven High after the eighth bit of the command code has been latched in, otherwise the Deep Power-Down (B9H) command is not executed. As soon as CS# is driven High, a delay of tDP occurs before the supply current is reduced to ISB2 and the Deep Power-Down mode is entered.

Any DP command, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.



### Figure-56. Deep Power-Down Sequence Diagram

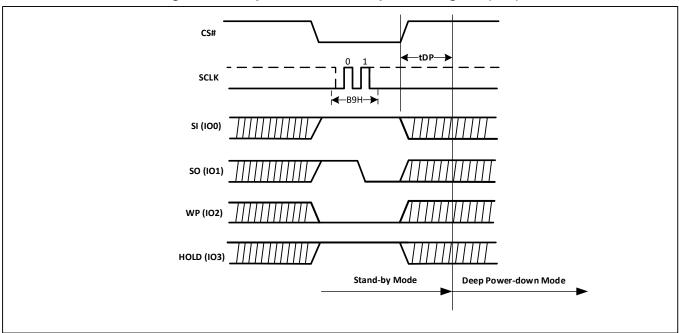


Figure-57. Deep Power-Down Sequence Diagram (QPI)

### 9.33 Release form Deep Power-Down (RDP), Read Electronic Signature (RES) (ABH)

Once the device has entered the Deep Power-Down mode, all commands are ignored except the Release from Deep Power-Down, Read Electronic Signature (ABH) command. Executing this command takes the device out of the Deep Power-Down mode.

Please note that this is not the same as or even a subset of, the JEDEC 16-bit Electronic Signature that is read by the Read Identification (9FH) command. The old-style Electronic Signature is supported for reasons of backward compatibility, only, and should not be used for new designs. New designs should, instead, make use of the JEDEC 16-bit Electronic Signature, and the Read Identification command.

When used only to release the device from the power-down state, the command is issued by driving the Chip Select (CS#) pin low, shifting the command code "ABH" and driving CS# high as shown in Figure-58. After the time duration of tRES1 the device will resume normal operation and other commands will be accepted. The CS# pin must remain high during the tRES1 time duration.

When used only to obtain the Device ID while not in the power-down state, the command is initiated by driving the CS# pin low and shifting the command code "ABH" followed by 3-dummy bytes. The Device ID bits are then shifted out on the falling edge of SCLK with the most significant bit (MSB) first as shown in Figure-60. The Device ID values are listed in "Tables of ID Definition" (Table-9). The Device ID can be read continuously. The command is completed by driving CS# high.

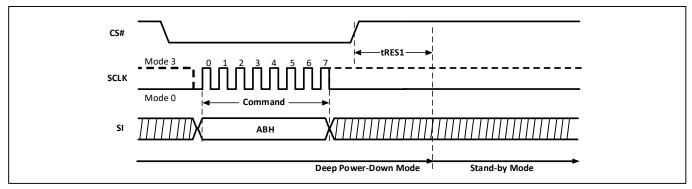
When CS# is driven High, the device is put in the Stand-by Power mode. If the device was not previously in the Deep Power-Down mode, the transition to the Stand-by Power mode is immediate. If the device was previously in the Deep Power-Down mode, though, the transition to the Stand-by Power mode is delayed by tRES2, and CS# must remain High for at least tRES2 (max). Once in the Stand-by Power mode, the device waits to be selected, so that it can receive, decode and execute commands.

Except while an Erase, Program or Write Status Register cycle is in progress, the RDP, RES command always provides access to the 8-bit Device ID of the device and can be applied even if the Deep Power-Down mode has not been entered.

Any RDP, RES command issued to the device while an Erase, Program or Write Status Register cycle is in progress, is not decoded, and has no effect on the cycle that is in progress.







### Figure-59. Release from Deep Power-Down (RDP) Sequence Diagram (QPI)

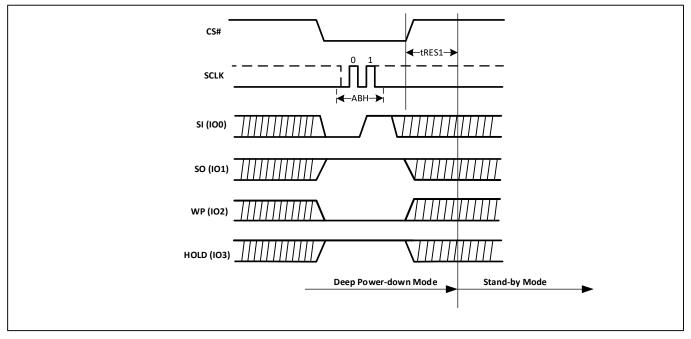
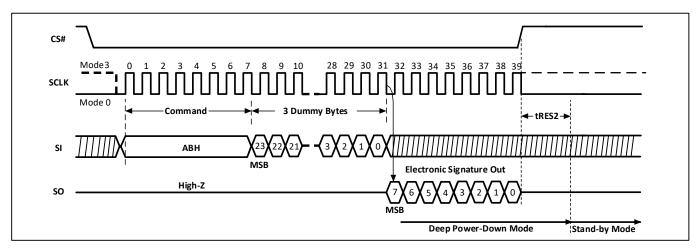
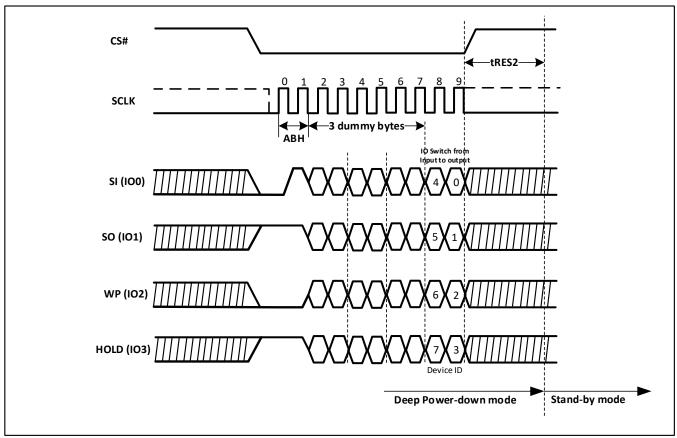


Figure-60. Read Electronic Signature (RES) Sequence Diagram





### Figure-61. Read Electronic Signature (RES) Sequence Diagram (QPI)

# 9.34 Read Electronic Manufacturer ID & Device ID (REMS) (90H)

The Read Electronic Manufacturer & Device ID (90H) command provides both the JEDEC assigned Manufacturer ID and the specific Device ID.

The REMS command is initiated by driving the CS# pin low and shifting the command code "90H" followed by two dummy bytes and one address byte (A7~A0). After which, the Manufacturer ID for UCUN (B3h) and the Device ID are shifted out on the falling edge of SCLK with the most significant bit (MSB) first as shown in Figure-63. The Device ID values are listed in "Tables of ID Definition" (Table-9). If the address byte is 00h, the manufacturer ID will be output first, followed by the device ID. If the address byte is 01h, then the device ID will be output first, followed by the manufacturer ID. While CS# is low, the Manufacturer and Device IDs can be read continuously, alternating from one to the other. The command is completed by driving CS# high.





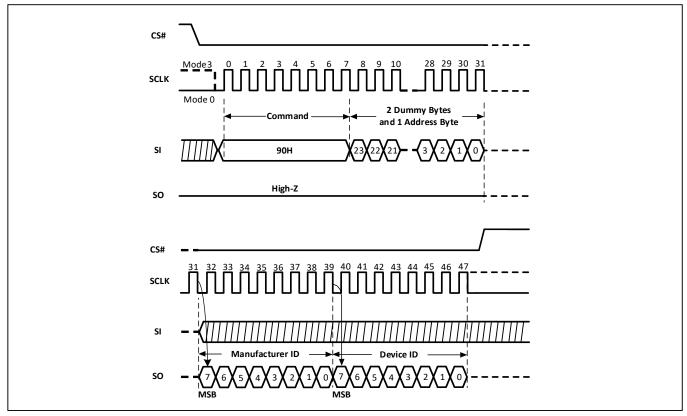
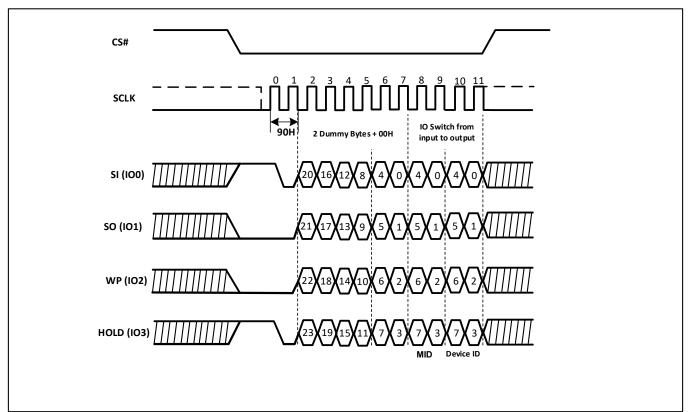


Figure-64. Read Electronic Manufacturer ID & Device ID Sequence Diagram (QPI)





# 9.35 Dual I/O Read Electronic Manufacturer ID & Device ID (DREMS) (92H)

The Dual I/O Read Electronic Manufacturer ID & Device ID (92H) command is similar to the Read Electronic Manufacturer & Device ID (90H) command and returns the JEDEC assigned Manufacturer ID which uses two pins: IO0, IO1 as address input and ID output I/O.

The DREMS command is initiated by driving the CS# pin low and shifting the DREMS command code "92h" followed by two dummy bytes, one address byte (A7~A0) and one byte of 'Continuous Read Mode' Bits. After which, the Manufacturer ID for UCUN (B3h) and the Device ID are shifted out on the falling edge of SCLK with the most significant bit (MSB) first. If the one-byte address is initially set to 01h, then the device ID will be read first and followed by the Manufacturer ID. The Manufacturer and Device IDs can be read continuously, alternating from one to the other. The DREMS command is completed by driving CS# high.

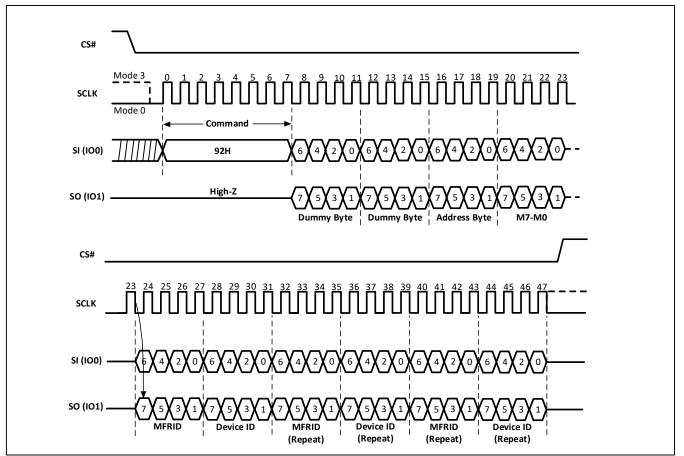


Figure-65. Dual I/O Read Electronic Manufacturer ID & Device ID Sequence Diagram

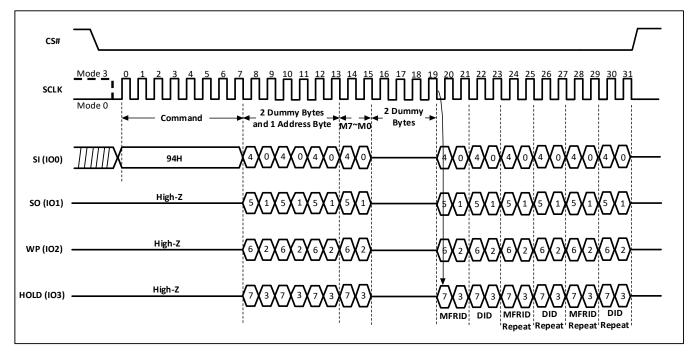
**Note**: The "Continuous Read Mode" bits (M5-4) must be set to (1,0) to be compatible with Dual I/O Fast Read command.

# 9.36 Quad I/O Read Electronic Manufacturer ID & Device ID (QREMS) (94H)

The Quad I/O Read Electronic Manufacturer ID & Device ID (94H) command is similar to the Read Electronic Manufacturer & Device ID (90H) command and returns the JEDEC assigned Manufacturer ID which uses four pins: IO0, IO1, IO2, IO3 as address input and ID output I/O. A Quad Enable (QE) of Status Register-2 must be executed before the device will accept the QREMS Command (The QE bit must equal "1").



The QREMS command is initiated by driving the CS# pin low and shifting the QREMS command code "94h" followed by two dummy bytes, one address (A7~A0) byte, one byte of 'Continuous Read Mode' Bits and two dummy bytes. After which, the Manufacturer ID for UCUN (B3h) and the Device ID are shifted out on the falling edge of SCLK with the most significant bit (MSB) first. If the one-byte address is initially set to 01h, then the device ID will be read first and then followed by the Manufacturer ID. The Manufacturer and Device IDs can be read continuously, alternating from one to the other. The QREMS command is completed by driving CS# high.





**Note**: The "Continuous Read Mode" bits (M5-4) must be set to (1,0) to be compatible with Quad I/O Fast Read command.

# 9.37 Read Identification (RDID) (9FH)

The Read Identification (9FH) command allows the 8-bit Manufacturer ID to be read, followed by two bytes of Device ID. The Device ID indicates the memory type in the first byte, and the memory capacity of the device in the second byte. The UCUN Manufacturer ID and Device ID are list as "Tables of ID Definition" (Table-9).

Any RDID command issued while an Erase or Program cycle is in progress, is not decoded, and has no effect on the cycle that is in progress. The RDID command should not be issued while the device is in Deep Power down mode.

The device is first selected by driving the CS# Low. Then the 8-bit command code for the command is shifted in. This is followed by the 24-bit device identification stored in the memory, shifted out on the SO pin on the falling edge of SCLK. The command sequence is shown in Figure-67. The RDID command is terminated by driving CS# High at any time during data output.

When CS# is driven High, the device is placed in the standby mode. Once in the standby stage, the device waits to be selected, so that it can receive, decode and execute commands.





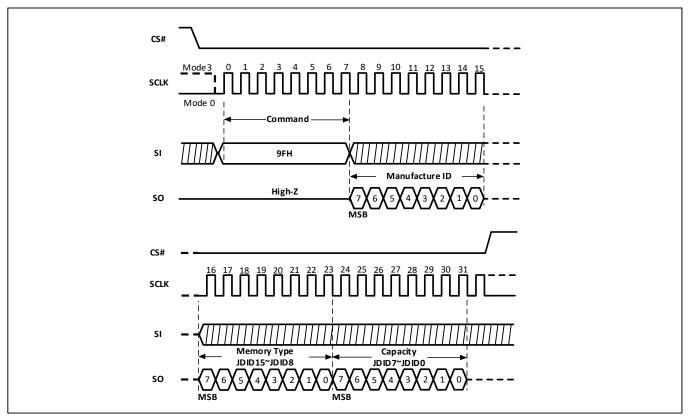
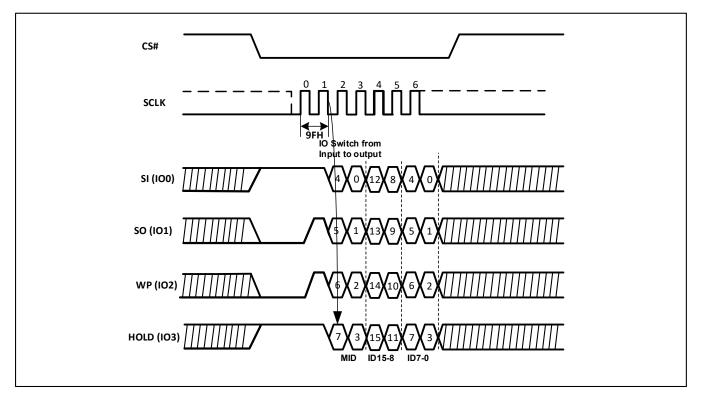


Figure-68. Read Identification Sequence Diagram (QPI)





## 9.38 Program/Erase Suspend/Resume (75H)

The Suspend (75H or B0H) command interrupts a Page Program, Page Erase, Sector Erase, Half Block Erase or Block Erase operation to allow access to the memory array. After the program or erase operation has entered the suspended state, the memory array can be read except for the page being programmed or the page, sector or block being erased.

Suspended Operation	Readable Region of Memory Array
Page Program	All but the Page being programmed
Page Erase	All but the Page being erased
Sector Erase(4KB)	All but the 4KB Sector being erased
Half Block Erase(32KB)	All but the 32KB Block being erased
Block Erase(64KB)	All but the 64KB Block being erased

Table-12.0 Readable Area of Memory While a Program or Erase Operation is Suspended

When the Serial NOR Flash receives the Suspend command, there is a latency of tPSL or tESL before the Write Enable Latch (WEL) bit clears to "0" and the SUS sets to "1". Afterwards, the device is ready to accept one of the commands listed in Table-11.1 "Acceptable Commands During Program/Erase Suspend after tPSL/tESL" (e.g. Read Data Bytes at Higher Speed (0BH) command). Refer to "AC CHARACTERISTICS" for tPSL and tESL timings. Table-11.2 "Acceptable Commands During Suspend (tPSL/tESL not required)" lists the commands for which the tPSL and tESL latencies do not apply. For example, Read Status Register, Read Security Registers, Reset Enable and Reset can be issued at any time after the Suspend command.

Status Register bit 15 (SUS) can be read to check the suspend status. The SUS (Program/Erase Suspend Bit) sets to "1" when a program or an erase operation is suspended. The SUS clears to "0" when the program or erase operation is resumed.

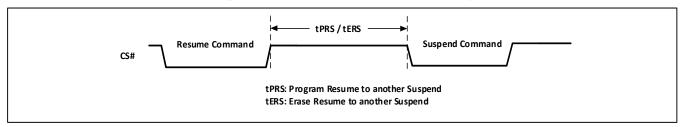
0	Osmunand Osda	Suspend	d Type
Command name	Command Code	Program Suspend	Erase Suspend
READ	03H	•	•
FAST READ	0BH	•	•
DREAD	3BH	•	•
QREAD	6BH	•	•
2READ	BBH	•	•
4READ	EBH	•	•
RDSFDP	5AH	•	•
RDID	9FH	•	•
REMS	90H	•	•
DREMS	92H	•	•
QREMS	94H	•	•
RDSCUR	48H	•	•
SBL	77H	•	•
WREN	06H		•
RESUME	7AH OR 30H	•	•
PP	02H		•
DPP	A2H		•
QPP	32H		•

Table-12.1 Acceptable Commands During Program/Erase Suspend after tPSL/tESL

Command name	Command Code	Suspen	d Type
Command name	Command Code	Program Suspend	Erase Suspend
WRDI	04H	•	•
RDSR	05H	•	•
RDSR2	35H	•	•
ASI	25H	•	•
RSTEN	66H	•	•
RST	99H	•	•
NOP	00H	•	•

### Table-12.2 Acceptable Commands During Suspend (tPSL/tESL not required)

#### Figure-69. Resume to Suspend Latency

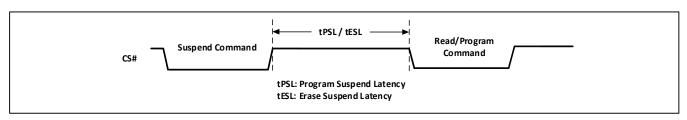


### **Erase Suspend to Program**

The "Erase Suspend to Program" feature allows Page Programming while an erase operation is suspended. Page Programming is permitted in any unprotected memory except within the sector of a suspended Sector Erase operation or within the block of a suspended Block Erase operation. The Write Enable (06H) command must be issued before any Page Program (02H) command.

A Page Program operation initiated within a suspended erase cannot itself be suspended and must be allowed to finish before the suspended erase can be resumed. The Status Register can be polled to determine the status of the Page Program operation. The Write Enable Latch (WEL) and Write in Progress (WIP) bits of the Status Register will remain "1" while the Page Program operation is in progress and will both clear to "0" when the Page Program operation completes.







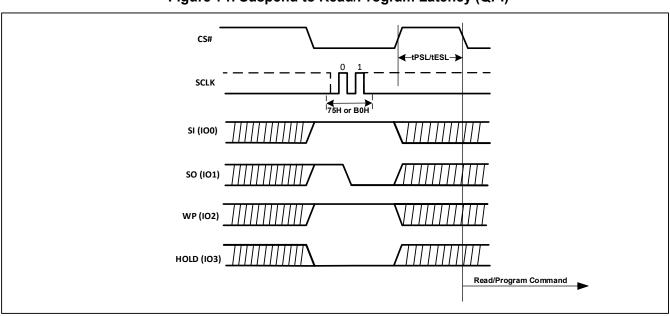


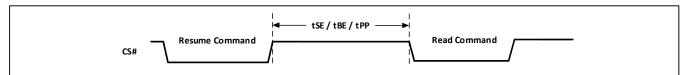
Figure-71. Suspend to Read/Program Latency (QPI)

### 9.39 Program Resume and Erase Resume (7AH)

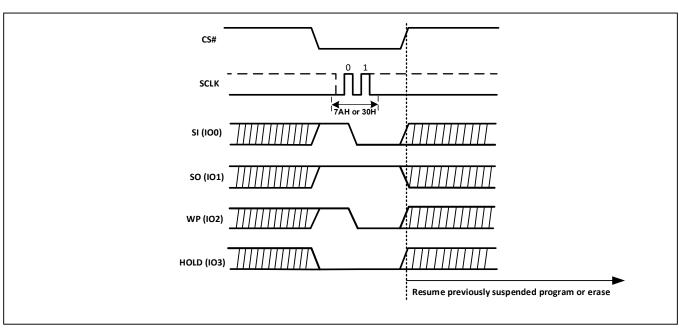
The Resume (7AH or 30H) command resumes a suspended Page Program, Page Erase, Sector Erase, Half Block Erase or Block Erase operation. Before issuing the Resume command to restart a suspended erase operation, make sure that there is no Page Program operation in progress.

Immediately after the Serial NOR Flash receives the Resume command, the Write Enable Latch (WEL) and Write in Progress (WIP) bits are set to "1" and the SUS is cleared to "0". The program or erase operation will continue until finished ("Resume to Read Latency") or until another Suspend (75H or B0H) command is received. A resume-to-suspend latency of tPRS or tERS must be observed before issuing another Suspend command ("Resume to Suspend Latency").









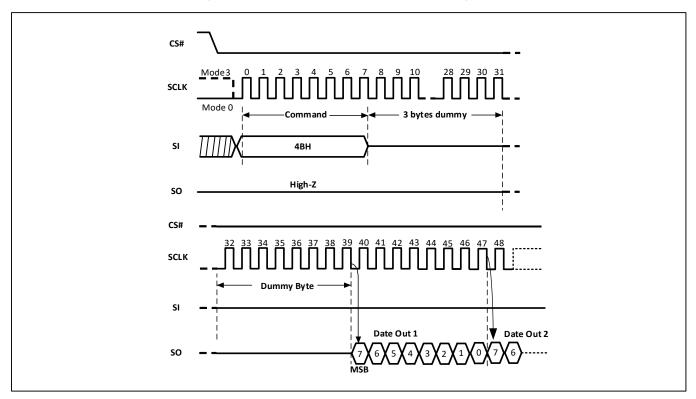
## Figure-73. Program Resume and Erase Resume Sequence Diagram (QPI)

# 9.40 Read Unique ID (RUID) (4BH)

The Read Unique ID (4BH) command accesses a factory-set read-only 128-bit number that is unique to each UC25HQ16 device. The ID number can be used in conjunction with user software methods to help prevent copying or cloning of a system.

The RUID command is initiated by driving the CS# pin low and shifting the command code "4BH" followed by four dummy bytes. Then, the 128-bit ID is shifted out on the falling edge of SCLK as shown in Figure-74.

Figure-74. Read Unique ID Sequence Diagram



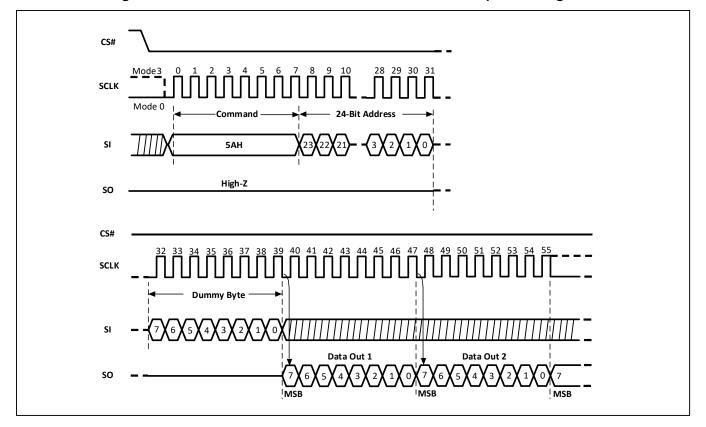
### 9.41 Read SFDP Mode (RDSFDP) (5AH)

The Serial Flash Discoverable Parameter (SFDP) standard provides a consistent method of describing the functional and feature capabilities of serial flash devices in a standard set of internal parameter tables. These parameter tables can be queried by host system software to enable adjustments needed to accommodate divergent features from multiple vendors. The concept is similar to the one found in the Introduction of JEDEC Standard, JESD68 on CFI. SFDP is a JEDEC Standard, JESD216B.

UC25HQ16 features the Read SFDP Mode (5AH) command. The host system can retrieve the operating characteristics, structure and vendor specified information such as identifying information, memory size, operating voltage and timing information of this device by SFDP mode.

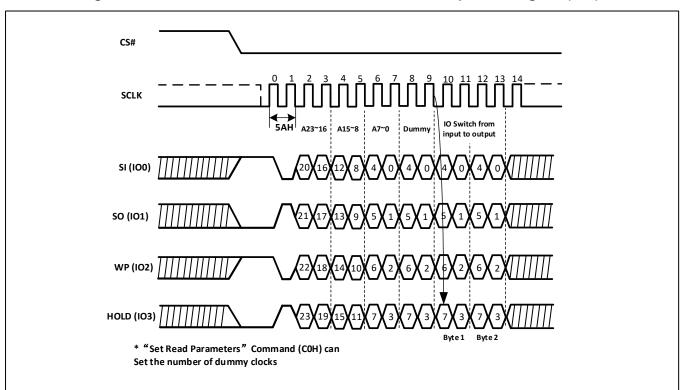
The device is first selected by driving Chip Select (CS#) Low. The command code for the RDSFDP is followed by a 3-byte address (A23~A0) and a dummy byte, with each bit latched-in on the rising edge of Serial Clock (SCLK). Then the memory contents, at the specified address, is shifted out on Data Output (SO) at a maximum frequency fC on the falling edge of SCLK.

The command sequence is shown in Figure-75. The first byte addressed can be at any location. The address is automatically incremented to the next higher address after each byte of data is shifted out. The entire SFDP table can, therefore, be read with a single RDSFDP command. When the highest address is reached, the address counter rolls over to 0x00h, allowing the read sequence to be continued indefinitely. The RDSFDP command is terminated by driving CS# High. CS# can be driven High at any time during data output. Any RDSFDP commands issued, while an Erase, Program or Write cycle is in progress, is rejected without having any effects on the cycle that is in progress.



### Figure-75. Read Serial Flash Discoverable Parameter Sequence Diagram





# Figure-76. Read Serial Flash Discoverable Parameter Sequence Diagram (QPI)



lable-13.	Serial Flash Discoverable Para	meter (S	FDP) Table	e	-
Description	Comment	Add (H)	DW Add	Data	Data
Description	Comment	(Byte)	(Bit)	Dala	Data
		00H	07:00	53H	53H
		01H	15:08	46H	46H
SFDP Signature	Fixed: 50444653H	02H	23:16	44H	44H
		03H	31:24	50H	50H
SFDP Minor Revision Number	Start from 00H	04H	07:00	00H	00H
SFDP Major Revision Number	Start from 01H	05H	15:08	01H	01H
Number of Parameters Headers	Start from 00H	06H	23:16	01H	01H
Unused	Contains 0xFFH and can never be changed	07H	31:24	FFH	FFH
ID number (JEDEC)	00H: It indicates a JEDEC specified header	08H	07:00	00H	00H
Parameter Table Minor Revision Number	Start from 0x00H	09H	15:08	00H	00H
Parameter Table Major Revision Number	Start from 0x01H	0AH	23:16	01H	01H
Parameter Table Length (in double word)	How many DWORDs in the Parameter table	0BH	31:24	09H	09H
		0CH	07:00	30H	30H
Parameter Table Pointer (PTP)	First address of JEDEC	0DH	15:08	00H	00H
	Flash Parameter table	0EH	23:16	00H	00H
Unused	Contains 0xFFH and can never be changed	0FH	31:24	FFH	FFH
ID Number (UCUN Device Manufacturer ID)	It is indicates UCUN manufacturer ID	10H	07:00	ВЗН	ВЗН
Parameter Table Minor Revision Number	Start from 0x00H	11H	15:08	00H	00H
Parameter Table Major Revision Number	Start from 0x01H	12H	23:16	01H	01H
Parameter Table Length (in double word)	How many DWORDs in the Parameter table	13H	31:24	03H	03H
		14H	07:00	60H	60H
Parameter Table Pointer (PTP)	First address of UCUN	15H	15:08	00H	00H
	Flash Parameter table	16H	23:16	00H	00H
Unused	Contains 0xFFH and can never be changed	17H	31:24	FFH	FFH

# Table-13. Serial Flash Discoverable Parameter (SFDP) Table



Image: constraint of the section o	Description	2	Add (H)	DW Add	Data	Dete
Biock/Sector Erase Size10: Reserved; 11: not support 4KB erase991:0001bWrite Cranularity0: 1Byte, 1: 64Byte or larger021bWrite Enable Instruction0: Nonvolatile status bit030bRequested for Writing to Volatile0: Use 50H Opcode, i: Use 60H Opcode, Note: If target flash status register is Note: If target flash status register is 10: 4 Byte only, 01: 3 or 4 Byte, 10: 4 B	Description	Comment	(Byte)	(Bit)	Data	Data
Initial and the state of the state state of the state of the state of the state		00: Reserved; 01: 4KB erase;				
Write Granularity         0: 1Byte, 1: 64Byte or larger         02         1b           Write Granularity         0: Nonvolatile status bit         0 <td< td=""><td>Block/Sector Erase Size</td><td>10: Reserved; 11: not support 4KB</td><td></td><td>01:00</td><td>01b</td><td></td></td<>	Block/Sector Erase Size	10: Reserved; 11: not support 4KB		01:00	01b	
Write Enable Instruction Requested for Writing to Volatile Status RegistersO. Nonvolatile status bit (BP status register bit)0. Nonvolatile status (BP status register bit)0. Nonvolatile status (D		erase	-			
Requested for Writing to Volatile Status Registers1: Volatile status bit (BP status register bit)030bWrite Enable Opcode Select for Writing to Volatile Status Registers0: Use 50H Opcode, 1: Use 00H Opcode, Novcialtile, then bits 3 and 4 must be set to 00b.30H0000UnusedContains 111b and can never be changed07.05111b004KB Erase Opcode31H15.0820H20H4KB Erase Opcode00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 01: 3 or 4 Byte, 11918:17000bCuble Transfer Rate (DTR) clocking 0 =Not support, 1=Support18:1700b111b(1-4.4) Fast Read0=Not support, 1=Support201b(1-4.4) Fast Read0=Not support, 1=Support201bUnused0=Not support, 1=Support211b(1-4.4) Fast Read Number of Watt States0000b: Wait states (Dummy Cycles) not support37H31.0000FFFFFH(1-4.4) Fast Read Number of Mode Bits0000b: Wait states (Dummy Cycles) not support38H15.08EBHEBH(1-1-4) Fast Read Number of Mode Bits0000b: Wait states (Dummy Cycles) not support32H30H30H20:160100b(1-1-4) Fast Read Number of	Write Granularity	0: 1Byte, 1: 64Byte or larger	-	02	1b	
Status Registers         (BP status register bit)         30H         Image: Construct on the status register bit)         30H         Image: Construct on the status register bit)         50H	Write Enable Instruction	0: Nonvolatile status bit				
Note:         It use 06H Opcode, 1: Use 06H Opcode, Note:         30H 1: Use 06H Opcode, Note:         30H 1: Use 06H Opcode, Note:         04         0b           Unused         Contains 111b and can never be changed         07.05         111b           4KB Erase Opcode         31H         15.08         20H         20H           4KB Erase Opcode         01: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 11: Reserved         32H         18:17         00b         7.05         111b           Address Bytes Number used in addressing flash array         00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 11: Reserved         32H         18:17         00b         7         11b         7           Double Transfer Rate (DTR) clocking         0=Not support, 1=Support         22         1b         18:17         00b         7         11b         7	Requested for Writing to Volatile	1: Volatile status bit		03	0b	
Write Enable Opcode Select for Writing to Volatile Status Registers Norvialitie, then bits 3 and 4 must be set to 00b.         04         0b           Unused         Contains 111b and can never be changed         07.05         111b           4KB Erase Opcode         Contains 111b and can never be changed         07.05         111b           4KB Erase Opcode         00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 01: 5 Byte, 10: 4 Byte only, 01: 5 Byte, 10: 4 Byte only, 01: 5 Byte, 10: 4 B	Status Registers	(BP status register bit)	30H			E5H
Write Enable Opcode Select for Writing to Volatile Status Registers Nonvolatile, then bits 3 and 4 must be set to 00b.         04         0b           Unused         Contains 111b and can never be changed         07.05         111b           4KB Erase Opcode         31H         15.08         20H         20H           (1-1-2) Fast Read         0=Not support, 1=Support         31H         15.08         20H         20H           Address Bytes Number used in addressing flash array         00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 11: Reserved         31H         16         1b         P1H           Double Transfer Rate (DTR) clocking         0=Not support, 1=Support         22         1b         1H           (1-2-2) Fast Read         0=Not support, 1=Support         22         1b         1H         1D           (1-4-4) Fast Read         0=Not support, 1=Support         22         1b         1H         1D           (1-4-4) Fast Read         0=Not support, 1=Support         22         1b         1H         1D           Unused         0=Not support, 1=Support         32H         31:24         FFH         FFH           (1-4-4) Fast Read Number of Wait         0000b: Wait states         0H         0O100b         0O100b         0H         1H           (1-4-4) Fast Read Number o		0: Use 50H Opcode,	3011			LOIT
Writing to Volatile Status Registers Nonvolatile, then bits 3 and 4 must be set to 00b.         04         0b           Unused         Contains 111b and can never be changed         07.05         111b           4KB Erase Opcode         31H         15.08         20H         20H           (1-1-2) Fast Read         0=Not support, 1=Support         31H         15.08         20H         20H           Address Bytes Number used in addressing flash array         00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 11: Reserved         31H         18:17         00b         PH           Double Transfer Rate (DTR) clocking         0=Not support, 1=Support         20         1b         PH           (1-4-4) Fast Read         0=Not support, 1=Support         20         1b         PH           (1-4-4) Fast Read         0=Not support, 1=Support         20         1b         PH           (1-4-4) Fast Read         0=Not support, 1=Support         21         1b         PH           (1-4-4) Fast Read         0=Not support, 1=Support         22         1b         PH           Unused         0 <not 1="Support&lt;/td" support,="">         31H         31.24         FFH         FFH           [1-4-4) Fast Read Number of Wait         0000b: Mode Bits not support         38H         31.00         000FFFFFH      <t< td=""><td>Write Enable Opcode Select for</td><td>1: Use 06H Opcode,</td><td></td><td></td><td></td><td></td></t<></not>	Write Enable Opcode Select for	1: Use 06H Opcode,				
Nonvolatile, then bits 3 and 4 must be set to 00b.         Image: marked m		Note: If target flash status register is		04	0b	
Unused         Contains 111b and can never be changed         07:05         111b           4KB Erase Opcode         31H         15:08         20H         20H           (1-1-2) Fast Read         0=Not support, 1=Support         31H         16         1b           Address Bytes Number used in addressing flash array         00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 11: Reserved         32H         16         1b           Double Transfer Rate (DTR) clocking         0=Not support, 1=Support         32H         10         1b           (1-2-2) Fast Read         0=Not support, 1=Support         20         1b         F1H           (1-4-4) Fast Read         0=Not support, 1=Support         21         1b         1b           (1-1-4) Fast Read         0=Not support, 1=Support         22         1b         1b           (1-4-4) Fast Read         0=Not support, 1=Support         23         1b         1b           (1-4-4) Fast Read         0=Not support, 1=Support         31H         31:00         00FFFFFF           Flash Memory Density         0000b: Wait states (Dummy Cycles) not support         38H         31:04         FFH           I-4-4-1 Fast Read Number of Mode Bits         0000b: Mode Bits not support         38H         04:00         00100b           (1-4-4) Fast R		Nonvolatile, then bits 3 and 4 must				
Unused         never be changed         07:05         111b           4KB Erase Opcode         31H         15:08         20H         20H           (1-1-2) Fast Read         0=Not support, 1=Support         16         1b         18:17         00b         18:17         00b         18:17         00b         16		be set to 00b.				
never be changed         Image (1-1-2)         Image (1-1-2) <thimage (1-1-2)<="" th="">         Image</thimage>	Unused	Contains 111b and can		07:05	111b	
International equation         Output		never be changed				
Address Bytes Number used in addressing flash array         00: 3 Byte only, 01: 3 or 4 Byte, 10: 4 Byte only, 11: Reserved         32H         18:17         00b           Double Transfer Rate (DTR) clocking         0=Not support, 1=Support         19         0b         19         0b           (1-2-2) Fast Read         0=Not support, 1=Support         20         1b         10         10           (1-4-4) Fast Read         0=Not support, 1=Support         21         1b         10         10           (1-1-4) Fast Read         0=Not support, 1=Support         22         1b         10         10           (1-1-4) Fast Read         0=Not support, 1=Support         23         1b         10         10           Unused         0=Not support, 1=Support         23         1b         22         1b         10           Unused         0=Not support, 1=Support         33H         31:24         FFH         FFH           (1-4-4) Fast Read Number of Wait         00000b: Wait states         04:00         00100b         00100b           (1-4-4) Fast Read Number of Mode         0000b: Mode Bits not support         38H         15:08         EBH         EBH           (1-1-4) Fast Read Number of Mode         0000b: Mode Bits not support         3AH         20:16         01000b	4KB Erase Opcode		31H	15:08	20H	20H
addressing flash array         10: 4 Byte only, 11: Reserved $32H$ 18:17         00b $F1H$ Double Transfer Rate (DTR) clocking         0=Not support, 1=Support         19         0b         20         1b           (1-2-2) Fast Read         0=Not support, 1=Support         20         1b         20         1b           (1-4-4) Fast Read         0=Not support, 1=Support         21         1b         22         1b           (1-1-4) Fast Read         0=Not support, 1=Support         22         1b         22         1b           Unused         0=Not support, 1=Support         23         1b         15         16           Unused         00000b: Wait states         33H         31:24         FFH         FFH           (1-4-4) Fast Read Number of Wait         00000b: Wait states         04:00         00100b         44H           (1-4-4) Fast Read Number of Mode         0000b:Mode Bits not support         38H         15:08         EBH         EBH           (1-1-4) Fast Read Number of Mode         0000b:Mode Bits not support         34H         20:16         0100b         08H           (1-1-4) Fast Read Number of Mode         0000b:Mode Bits not support         34H         20:16         01000b         08H	(1-1-2) Fast Read	0=Not support, 1=Support	-	16	1b	
addressing flash array         10: 4 Byte only, 11: Reserved         32H         Image: Constraint of the second	Address Bytes Number used in	00: 3 Byte only, 01: 3 or 4 Byte,		18:17	00b	
Initial data (c, d, mark)         I	addressing flash array	10: 4 Byte only, 11: Reserved	32H			F1H
(1-4-4) Fast Read $0=Not$ support, $1=Support$ $21$ $1b$ $(1-1-4)$ Fast Read $0=Not$ support, $1=Support$ $22$ $1b$ $Unused$ $0=Not$ support, $1=Support$ $23$ $1b$ $Unused$ $33H$ $31:24$ $FFH$ $FFH$ $Inused$ $33H$ $31:24$ $FFH$ $FFH$ $Inused$ $00000b:$ Wait states (Dummy Cycles) not support $37H:34H$ $31:00$ $00FFFFFFH$ $(1-4-4)$ Fast Read Number of Wait Bits $000b:Mode$ Bits not support $38H$ $04:00$ $00100b$ $(1-4-4)$ Fast Read Number of Mode Bits $000b:Mode$ Bits not support $39H$ $15:08$ $EBH$ $EBH$ $(1-4-4)$ Fast Read Number of Wait states $0000b:$ Wait states (Dummy Cycles) not support $20:16$ $0100b$ $08H$ $(1-1-4)$ Fast Read Number of Mode Bits $000b:Mode$ Bits not support $3BH$ $31:24$ $6BH$ $6BH$ $(1-1-4)$ Fast Read Number of Mode Bits $000b:Mode$ Bits not support $3BH$ $31:24$ $6BH$ $6BH$ $(1-1-4)$ Fast Read Opcode $000b:Mode$ Bits not support $3BH$ $31:24$ $6BH$ $6BH$ $(1-1-4)$ Fast Read Opcode $0000b:$ Wait states $Bits$ $3CH$ $04:00$ $01000b$ $08H$	Double Transfer Rate (DTR) clocking	0=Not support, 1=Support		19	0b	
(1-1-4) Fast Read $0=Not support, 1=Support$ $22$ $1b$ $Unused$ $23$ $1b$ $Unused$ $33H$ $31:24$ $FFH$ $FFH$ $(1-4-4)$ Fast Read Number of Wait states $00000b$ : Wait states (Dummy Cycles) not support $37H:34H$ $31:00$ $00FFFFFH$ $(1-4-4)$ Fast Read Number of Mode Bits $0000b$ :Mode Bits not support $38H$ $04:00$ $00100b$ $44H$ $(1-4-4)$ Fast Read Number of Mode Bits $000b$ :Mode Bits not support $39H$ $15:08$ $EBH$ $EBH$ $(1-1-4)$ Fast Read Number of Wait states $0000b$ : Wait states (Dummy Cycles) not support $39H$ $15:08$ $EBH$ $EBH$ $(1-1-4)$ Fast Read Number of Wait states $0000b$ : Wait states (Dummy Cycles) not support $3H$ $31:24$ $6BH$ $6BH$ $(1-1-4)$ Fast Read Number of Mode Bits $000b$ :Mode Bits not support $3H$ $31:24$ $6BH$ $6BH$ $(1-1-4)$ Fast Read Opcode $000b$ :Mode Bits not support $3H$ $31:24$ $6BH$ $6BH$ $(1-1-4)$ Fast Read Opcode $0000b$ : Wait states $Bits$ $3CH$ $04:00$ $01000b$ $08H$	(1-2-2) Fast Read	0=Not support, 1=Support		20	1b	
Unused231bUnused33H31:24FFHFFHUnused37H:34H31:0000FFFFHFlash Memory Density37H:34H31:0000FFFFH(1-4-4) Fast Read Number of Wait states (Dummy Cycles) not support $37H:34H$ 31:00000FFFFH(1-4-4) Fast Read Number of Mode Bits000b:Mode Bits not support $38H$ $04:00$ $00100b$ (1-4-4) Fast Read Number of Mode Bits000b:Mode Bits not support $38H$ $07:05$ $010b$ $44H$ (1-4-4) Fast Read Opcode39H15:08EBHEBH(1-1-4) Fast Read Number of Wait states (Dummy Cycles) not support $0000b:Wait states$ (Dummy Cycles) not support $20:16$ $01000b$ (1-1-4) Fast Read Number of Mode Bits $000b:Mode Bits not support$ $3AH$ $20:16$ $01000b$ $08H$ (1-1-4) Fast Read Number of Mode Bits $000b:Mode Bits not support$ $3BH$ $31:24$ $6BH$ $6BH$ (1-1-4) Fast Read Opcode3BH $31:24$ $6BH$ $6BH$ (1-1-2) Fast Read Number of Wait Bits $00000b:Wait states$ $00000b:Wait states3CH04:0001000b08H$	(1-4-4) Fast Read	0=Not support, 1=Support		21	1b	
Unused33H31:24FFHFFHIlash Memory Density37H:34H31:0000FFFFFH(1-4-4) Fast Read Number of Wait states00000b: Wait states (Dummy Cycles) not support $04:00$ $00100b$ $00100b$ (1-4-4) Fast Read Number of Mode Bits000b:Mode Bits not support $38H$ $04:00$ $00100b$ $44H$ (1-4-4) Fast Read Number of Mode Bits000b:Mode Bits not support $39H$ $15:08$ EBHEBH(1-1-4) Fast Read Opcode000b: Wait states (Dummy Cycles) not support $39H$ $15:08$ EBHEBH(1-1-4) Fast Read Number of Wait states0000b: Wait states (Dummy Cycles) not support $20:16$ $01000b$ $08H$ (1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support $34H$ $20:16$ $01000b$ $08H$ (1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support $34H$ $20:16$ $01000b$ $08H$ (1-1-4) Fast Read Number of Mode Bits0000b:Wait states (Dummy Cycles) not support $3BH$ $31:24$ $6BH$ $6BH$ (1-1-2) Fast Read Opcode00000b: Wait states (Du000b: Wait states $3CH$ $04:00$ $01000b$ $08H$	(1-1-4) Fast Read	0=Not support, 1=Support		22	1b	
Flash Memory Density37H:34H31:00 $00FFFFFH$ (1-4-4) Fast Read Number of Wait states00000b: Wait states (Dummy Cycles) not support $04:00$ $00100b$ $44H$ (1-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support $38H$ $07:05$ $010b$ $44H$ (1-4-4) Fast Read Opcode000b: Mode Bits not support $39H$ $15:08$ $EBH$ $EBH$ (1-1-4) Fast Read Number of Wait states00000b: Wait states (Dummy Cycles) not support $39H$ $15:08$ $EBH$ $EBH$ (1-1-4) Fast Read Number of Wait states00000b: Wait states (Dummy Cycles) not support $3AH$ $20:16$ $0100b$ $08H$ (1-1-4) Fast Read Number of Mode Bits000b: Mode Bits not support $3AH$ $23:21$ $000b$ $08H$ (1-1-4) Fast Read Opcode3BH $31:24$ $6BH$ $6BH$ (1-1-2) Fast Read Number of Wait (1-1-2) Fast Read Number of Wait $00000b: Wait states$ $00000b: Wait states3CH04:0001000b08H$	Unused			23	1b	
(1-4-4) Fast Read Number of Wait states (1-4-4) Fast Read Number of Mode Bits00000b: Wait states (Dummy Cycles) not support04:0000100b44H(1-4-4) Fast Read Number of Mode Bits000b: Mode Bits not support38H07:05010b44H(1-4-4) Fast Read Opcode000b: Mode Bits not support39H15:08EBHEBH(1-1-4) Fast Read Number of Wait states (Dummy Cycles) not support0000b: Wait states (Dummy Cycles) not support39H15:08EBHEBH(1-1-4) Fast Read Number of Mode Bits0000b: Mode Bits not support3AH20:1601000b08H(1-1-4) Fast Read Number of Mode Bits000b: Mode Bits not support3BH31:246BH6BH(1-1-2) Fast Read Opcode00000b: Wait states 00000b: Wait states3CH04:0001000b08H	Unused		33H	31:24	FFH	FFH
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	Flash Memory Density		37H:34H	31:00	00FFFF	FFH
states(Dummy Cycles) not support38HAutor44H(1-4-4) Fast Read Number of Mode Bits000b:Mode Bits not support38H07:05010b44H(1-4-4) Fast Read Opcode000b:Mode Bits not support39H15:08EBHEBH(1-1-4) Fast Read Number of Wait states00000b: Wait states (Dummy Cycles) not support39H15:08EBHEBH(1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support3AH20:160100b01000b(1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support3BH31:246BH6BH(1-1-2) Fast Read Number of Wait00000b: Wait states 00000b: Wait states3CH04:0001000b08H	(1-4-4) Fast Read Number of Wait	00000b: Wait states			00400	
(1-4-4) Fast Read Number of Mode Bits $000b:Mode Bits not support$ $07:05$ $010b$ $(1-4-4)$ Fast Read Opcode $39H$ $15:08$ $EBH$ $EBH$ $(1-4-4)$ Fast Read Number of Wait states $00000b:$ Wait states $(Dummy Cycles) not support$ $39H$ $15:08$ $EBH$ $EBH$ $(1-1-4)$ Fast Read Number of Mode Bits $000b:Mode Bits not support$ $3AH$ $20:16$ $0100b$ $000b$ $(1-1-4)$ Fast Read Number of Mode Bits $000b:Mode Bits not support$ $3AH$ $23:21$ $000b$ $08H$ $(1-1-4)$ Fast Read Opcode $0000b:$ Wait states $3BH$ $31:24$ $6BH$ $6BH$ $(1-1-2)$ Fast Read Number of Wait $00000b:$ Wait states $3CH$ $04:00$ $01000b$ $08H$	states	(Dummy Cycles) not support	0011	04:00	001000	4.41.1
(1-1-4) Fast Read Number of Wait states (1-1-4) Fast Read Number of Mode Bits00000b: Wait states (Dummy Cycles) not support20:1601000b08H(1-1-4) Fast Read Number of Mode Bits000b: Mode Bits not support3AH20:1601000b08H(1-1-4) Fast Read Opcode000b: Mode Bits not support3BH31:246BH6BH(1-1-2) Fast Read Number of Wait00000b: Wait states3CH04:0001000b08H		000b:Mode Bits not support	38H	07:05	010b	44⊓
states(Dummy Cycles) not support3AH20:1601000b(1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support3AH23:21000b(1-1-4) Fast Read Opcode0000b:Wolt States3BH31:246BH6BH(1-1-2) Fast Read Number of Wait00000b: Wait states3CH04:0001000b08H	(1-4-4) Fast Read Opcode		39H	15:08	EBH	EBH
states(Dummy Cycles) not support3AHAnd08H(1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support23:21000b000b(1-1-4) Fast Read Opcode3BH31:246BH6BH(1-1-2) Fast Read Number of Wait00000b: Wait states3CH04:0001000b08H	(1-1-4) Fast Read Number of Wait	00000b: Wait states			04000	
(1-1-4) Fast Read Number of Mode Bits000b:Mode Bits not support23:21000b(1-1-4) Fast Read Opcode3BH31:246BH6BH(1-1-2) Fast Read Number of Wait00000b: Wait states3CH04:0001000b08H	states	(Dummy Cycles) not support		20:16	01000b	0011
(1-1-2) Fast Read Number of Wait 00000b: Wait states 3CH 04:00 01000b 08H		000b:Mode Bits not support	3AH	23:21	000b	UOH
3CH 04:00 01000b 08H	(1-1-4) Fast Read Opcode		3BH	31:24	6BH	6BH
	(1-1-2) Fast Read Number of Wait states	00000b: Wait states (Dummy Cycles) not support	зсн	04:00	01000b	08H



		Add (H)	DW Add		
Description	Comment	(Byte)	(Bit)	Data	Data
(1-1-2) Fast Read Number of Mode Bits	000b: Mode Bits not support	3CH	07:05	000b	08H
(1-1-2) Fast Read Opcode		3DH	15:08	3BH	3BH
(1-2-2) Fast Read Number of Wait	00000b: Wait states		20:16	00000b	
states	(Dummy Cycles) not support	3EH	20.10	000000	80H
(1-2-2) Fast Read Number of Mode Bits	000b: Mode Bits not support	0EH	23:21	100b	0011
(1-2-2) Fast Read Opcode		3FH	31:24	BBH	BBH
(2-2-2) Fast Read	0=not support 1=support		00	0b	
Unused		4011	03:01	111b	
(4-4-4) Fast Read	0=not support 1=support	40H	04	0b	EEH
Unused			07:05	111b	
Unused		43H:41H	31:08	FFH	FFH
Unused		45H:44H	15:00	FFH	FFH
(2-2-2) Fast Read Number of Wait states	00000b: Wait states (Dummy Cycles) not support		20:16	00000b	
(2-2-2) Fast Read Number of Mode Bits	000b: Mode Bits not support	46H	23:21	000b	00H
(2-2-2) Fast Read Opcode		47H	31:24	FFH	FFH
Unused		49H:48H	15:00	FFH	FFH
(4-4-4) Fast Read Number of Wait states	00000b: Wait states (Dummy Cycles) not support	4AH	20:16	00000b	00H
(4-4-4) Fast Read Number of Mode Bits	000b: Mode Bits not support		23:21	000b	
(4-4-4) Fast Read Opcode		4BH	31:24	FFH	FFH
Sector Type 1 Size	Sector/block size=2^N bytes 0x00b: this sector type doesn't exist	4CH	07:00	0CH	0CH
Sector Type 1 erase Opcode		4DH	15:08	20H	20H
Sector Type 2 Size	Sector/block size=2^N bytes 0x00b: this sector type doesn't exist	4EH	23:16	0FH	0FH
Sector Type 2 erase Opcode		4FH	31:24	52H	52H
Sector Type 3 Size	Sector/block size=2^N bytes 0x00b: this sector type doesn't exist	50H	07:00	10H	10H
Sector Type 3 erase Opcode		51H	15:08	D8H	D8H
Sector Type 4 Size	Sector/block size=2^N bytes 0x00b: this sector type doesn't exist	52H	23:16	08H	08H
Sector Type 4 erase Opcode		53H	31:24	81H	81H



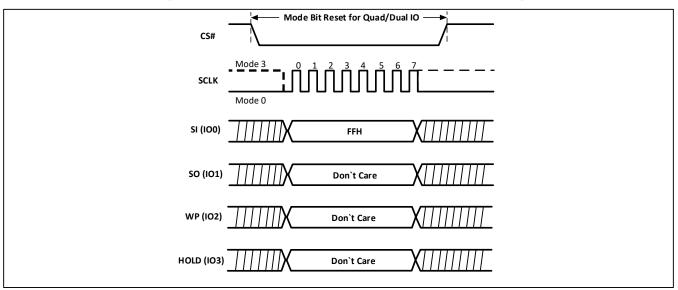
Description	Comment	Add (H)	DW Add	Data	Data
		(Byte)	(Bit)		
Vcc Supply Maximum Voltage	2000H=2.000V	61H:60H	15:00	2000H	2000Н
	2700H=2.700V				
	3600H=3.600V				
Vcc Supply Minimum Voltage	1650H=1.650V	63H:62H	31:16	1650H	2300H
	2250H=2.250V				
	2350H=2.350V				
	2700H=2.700V				
HW Reset# pin	0=not support 1=support	-	00	0b	F99EH
HW Hold# pin	0=not support 1=support		01	1b	
Deep Power Down Mode	0=not support 1=support		02	1b	
SW Reset	0=not support 1=support		03	1b	
SW Reset Opcode	Should be issue Reset Enable (66H)	65H:64H	11:04	1001 1001b	
	before Reset cmd.			(99H)	
Program Suspend/Resume	0=not support 1=support		12	1b	
Erase Suspend/Resume	0=not support 1=support		13	1b	
Unused			14	1b	
Wrap-Around Read mode	0=not support 1=support		15	1b	
Wrap-Around Read mode Opcode		66H	23:16	77H	77H
Wrap-Around Read data length	08H:support 8B Wrap-Around read	67H	31:24	64H	64H
	16H:8B&16B				
	32H:8B&16B&32B				
	64H:8B&16B&32B&64B				
Individual block lock	0=not support 1=support		00	0b	CBFCH
Individual block lock bit	0=Volatile 1=Nonvolatile		01	0b	
(Volatile/Nonvolatile)	0=Volatile 1=Nonvolatile		01	dU	
Individual block lock Opcode			09:02	FFH	
Individual block lock Volatile		6BH:68H		0b	
protect bit default protect status	0=protect 1=unprotect		10		
Secured OTP	0=not support 1=support		11	1b	
Read Lock	0=not support 1=support		12	0b	
Permanent Lock	0=not support 1=support		13	0b	
Unused			15:14	11b	
Unused			31:16	FFFFH	FFFFH

## 9.42 Continuous Read Mode Reset (CRMR) (FFH)

The "Continuous Read Mode" bits are used in conjunction with Dual I/O Fast Read (BBH) and Quad I/O Fast Read (EBH) commands to provide the highest random Flash memory access rate with minimum SPI command overhead, thus allowing more efficient XIP (execute in place) with this device family. A device that is in a continuous high performance read mode may not recognize any normal SPI command or the Software Reset (66H, 99H) command. It is recommended to use the Continuous Read Mode Reset (FFH) command after a system Power on Reset or, before sending a Software Reset, to ensure the device is released from "Continuous Read Mode".

The "Continuous Read Mode" bits M7-0 are set by the Dual/Quad I/O Fast Read (BBH or EBH) commands. M5-4 are used to control whether the 8-bit SPI command code (BBH or EBH) is needed or not for the next command. When M5-4 = (1,0), the next command will be treated the same as the current Dual/Quad I/O Fast Read command without requiring the 8-bit command code; when M5-4 do not equal (1,0), the device returns to normal SPI command mode, in which all commands can be accepted. M7-6 and M3-0 are reserved bits for future use, either 0 or 1 values can be used.

Because the UC25HQxx has no hardware reset pin, if Continuous Read Mode bits are set to (1,0), the UC25HQxx will not recognize any standard SPI commands. The Continuous Read Mode Reset (FFH) will release the "Continuous Read Mode" and return to normal SPI operation (if in QPI mode, then exit QPI mode together). The command sequence is shown in Figure-77.

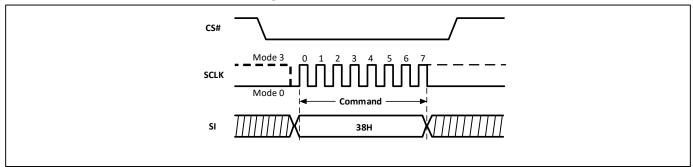


### Figure-77. Continuous Read Mode Reset Sequence Diagram

### 9.43 Enable QPI (38H)

The device support both Standard/Dual/Quad SPI and QPI mode. The "Enable QPI (38H)" command can switch the device from SPI mode to QPI mode. See the command Table 8 for all support QPI commands. In order to switch the device to QPI mode, the Quad Enable (QE) bit in Status Register-1 must be set to 1 first, and "Enable QPI (38H)" command must be issued. If the QE bit is 0, the "Enable QPI (38H)" command will be ignored and the device will remain in SPI mode. When the device is switched from SPI mode to QPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.

Figure 78. Enable QPI (QPI)

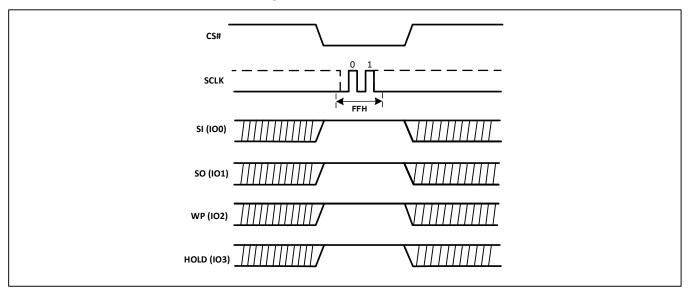


# 9.44 Disable QPI (FFH)

To exit the QPI mode and return to Standard/Dual/Quad SPI mode, 1) Using "Disable QPI (FFH)" command . 2) Setting QE bit =0, the QPI mode will switch to SPI mode. When the device is switched from QPI mode to SPI mode, the existing Write Enable Latch and Program/Erase Suspend status, and the Wrap Length setting will remain unchanged.

Note : this command will exit "Continue read mode" together See 9.41

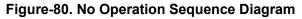
Figure 79. Disable QPI (QPI)

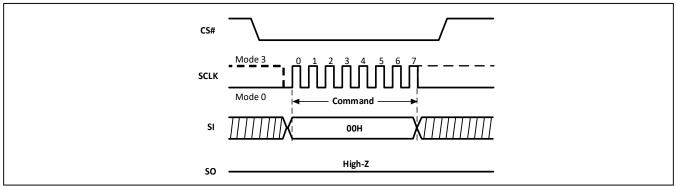


# 9.45 No Operation (NOP)

The No Operation (00H) command is only able to terminate the Reset Enable (66H) command and will not affect any other command.

The IO[3:1] are don't care.





# 9.46 Reset Enable (RSTEN) (66H) and Reset (RST) (99H)

The Software Reset operation combines two commands: Reset Enable (66H) command and Reset (99H) command. It returns the device to standby mode. All the volatile bits and settings will be cleared which returns the device to the same default status as power on. The Reset command immediately following a Reset Enable command, initiates the Software Reset process. Any command other than Reset following the Reset Enable command, will clear the reset enable condition and prevent a later Reset command from being recognized.

If the Reset command is executed during a program or erase operation, the operation will be disabled and the data under processing could be damaged or lost.

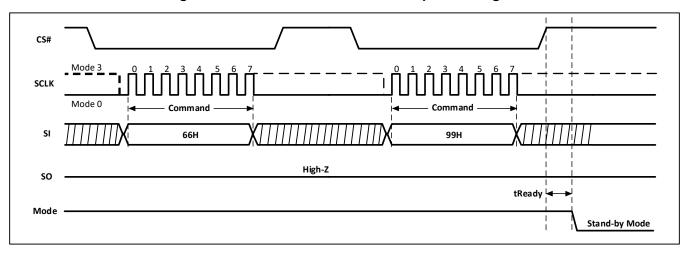


Figure-81. Reset Enable and Reset Sequence Diagram

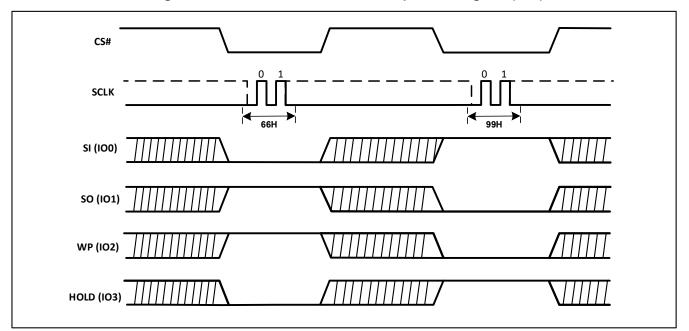


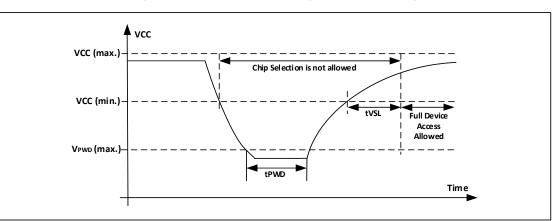
Figure-82 Reset Enable and Reset Sequence Diagram (QPI)



# **10. ELECTRICAL SPECIFICATIONS**

## 10.1 Power-On Timing





### Table-14 Power-Up Timing and Write Inhibit Threshold

Sym.	Parameter	Min.	Max.	Unit
tVSL	VCC(min.) to device operation	0.3		ms
VWI	Write Inhibit Voltage	1	1.55	V
VPWD	VCC voltage needed to below VPWD for ensuring initializtion will occur		1.1	V
tPWD	The minimum duration for ensuring initialization will occur	300		us

# 10.2 Initial Delivery State

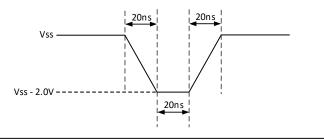
The device is delivered with the memory array erased: all bits are set to 1(each byte contains FFH). The Status Register contains 00H (all Status Register bits are 0)

### 10.3 Absolute Maximum Ratings

Parameter	Value	Unit
Ambient Operating Temperature	-40 to 85	°C
Storage Temperature	-65 to 150	°C
Applied Input / Output Voltage	-0.6 to VCC+0.4	V
Transient Input / Output Voltage(note: overshoot)	-2.0 to VCC+2.0	V
VCC	-0.6 to 4.2	V

# Figure-84. Maximum Negative/positive Overshoot Diagram





20ns

20ns

Vcc



### **10.4 AC Measurement Conditions**

Table-16. AC Measurement Conditions

Sym.	Parameter	Min.	Тур.	Мах	Unit	Conditions
CIN	Input Capacitance			6	рF	VIN = GND
COUT	Output Capacitance			8	pF	VOUT = GND
CL	Load Capacitance		30		pF	
	Input			5	ns	
	Input Pulse Voltage	0.1\	'CC to 0.	8VCC	V	
	Input Timing Reference Voltage	0.2	0.2VCC to 0.7VCC		V	
	Output Timing Reference Voltage		0.5VCC			

# 10.5 DC Characteristics

# Table-17. DC Parameters (Ta=-40°C to +85°C )

Cumhal	Devementer	Conditions	2.3	3V to 3.	6V	
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
IDPD	Deep power down current	CS#=Vcc, all other inputs at 0V or Vcc		0.3	3.0	uA
ISB	Standby current	CS#, HOLD#, WP#=Vcc all inputs at CMOS levels		10	15	uA
ICC1	Low power read	f=1MHz; IOUT=0mA		1.0	1.5	mA
1001	current (03h)	f=33MHz; IOUT=0mA		2.0	3.0	mA
ICC2	Road ourrant (0Ph)	f=50MHz; IOUT=0mA		3.0	6.0	mA
1002	Read current (0Bh)	f=85MHz; IOUT=0mA		4.5	8.0	mA
ICC3	Program current	CS#=Vcc		4.0	6.0	mA
ICC4	Erase current	CS#=Vcc		3.0	4.0	mA
ICC5	Write current	CS#=Vcc		3.0	4.0	mA
ILI	Input load current	All inputs at CMOS level			1.0	uA
ILO	Output leakage	All inputs at CMOS level			1.0	uA
VIL	Input low voltage				0.2Vcc	V
VIH	Input high voltage		0.8Vcc			V
VOL	Output low voltage	IOL=100uA			0.2	V
VOH	Output high voltage	IOH=-100uA	Vcc-0.2			V

### Note:

1. Typical values measured at 3.0V @ 25°C for the 2.3V to 3.6V range.



# **10.6 AC Characteristics**

# Table-18. AC Parameters (Ta=-40°C to +85°C )

	A.14		2	.3V~3.6	V	
Symbol	Alt.	Parameter			max	Unit
fsclk	fC	Clock Frequency for the following instructions: FAST_READ, RDSFDP, PP,			104	MHz
ISOK		SE, BE32K, BE, CE, DP,RES, WREN, WRDI, RDID, RDSR, WRSR(7)			104	
fRSCLK	fR	Clock Frequency for READ instructions			50	MHz
	fT	Clock Frequency for DREAD instructions			104	MHz
fTSCLK		Clock Frequency for 2READinstructions			85	MHz
HOOLK	fQ	Clock Frequency for QREAD instructions			85	MHz
		Clock Frequency for 4READ instructions			85	MHz
fQPP		Clock Frequency for QPP (Quad page program)			104	MHz
tCH(1)	tCLH	Clock High Time	4.0			ns
tCL(1)	tCLL	Clock Low Time (fSCLK) 45% x (1fSCLK)	4.0			ns
tCLCH(7)		Clock Rise Time (peak to peak)	0.1			v/ns
tCHCL(7)		Clock Fall Time (peak to peak)	0.1			v/ns
tSLCH	tCSS	CS# Active Setup Time (relative to SCLK)	5			ns
tCHSL		CS# Not Active Hold Time (relative to SCLK)	5			ns
tDVCH	tDSU	Data In Setup Time	2			ns
tCHDX	tDH	Data In Hold Time	3			ns
tCHSH		CS# Active Hold Time (relative to SCLK)	5			ns
tSHCH		CS# Not Active Setup Time (relative to SCLK)	5			ns
		CS# Deselect Time From Read to next Read	20			ns
tSHSL	tCSH	CS# Deselect Time From Write,Erase,Program to Read Status Register	20			ns
		Volatile Status Register Write Time	20			ns
tSHQZ(7)	tDIS	Output Disable Time			6	ns
		Clock Low to Output Valid Loading 30pF			7	ns
tCLQV	tV	Clock Low to Output Valid Loading 15pF			6	ns
tCLQX	tHO	Output Hold Time	0			ns
tHLCH		HOLD# Active Setup Time (relative to SCLK)	5			ns
tCHHH		HOLD# Active Hold Time (relative to SCLK)	5			ns
tHHCH		HOLD# Not Active Setup Time (relative to SCLK)	5			ns
tCHHL		HOLD# Not Active Hold Time (relative to SCLK)	5			ns
tHHQX	tLZ	HOLD# to Output Low-Z			6	ns
tHLQZ	tHZ	HOLD# to Output High-Z			6	ns
tWHSL(3)		Write Protect Setup Time	20			ns
tSHWL(3)		Write Protect Hold Time	100			ns
tDP		CS# High to Deep Power-down Mode			2	us
tRES1		CS# High To Standby Mode Without Electronic Signature Read			5	us
tRES2		CS# High To Standby Mode With Electronic Signature Read	1		5	us
tW		Write Status Register Cycle Time		8	12	ms
		Reset recovery time(for erase/program operation except WRSR)	50			us
tReady		Reset recovery time(for WRSR operation)	1	8	12	ms



Table-19. AC Parameters for Program and Erase(Ta=-40°C to +85°C )											
Sum	Parameter	2	.3V to 3.6	V	Units						
Sym.	Parameter	Min.	Тур.	Max.	Units						
TESL(6)	Erase Suspend Latency			45	us						
TPSL(6)	Program Suspend Latency			45	us						
TPRS(4)	Latency between Program Resume and next Suspend	0.3			us						
TERS(5)	Latency between Erase Resume and next Suspend	0.3			us						
tPP	Page program time (up to 256 bytes)		2	3	ms						
tPE	Page erase time		10	20	ms						
tSE	Sector erase time		10	20	ms						
tBE1	Block erase time for 32K bytes		10	20	ms						
tBE2	Block erase time for 64K bytes		10	20	ms						
tPW	Write time (up to 256 bytes)		10	20	ms						
tCE	Chip erase time		80	160	ms						

#### Table-19. AC Parameters for Program and Erase(Ta=-40°C to +85°C )

#### Notes:

1. tCH + tCLmust be greater than or equal to 1/Frequency.

2. Typical values given for TA=25°C. Not 100% tested.

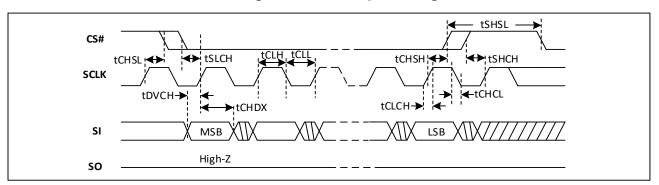
3. Only applicable as a constraint for a WRSR command.

4. Program operation may be interrupted as often as system request. The minimum timing of tPRS must be observed before issuing the next program suspend command. However, for a Program operation to make progress, tPRS ≥ 100us must be included in resume-to-suspend loop(s). Not 100% tested.

 Erase operation may be interrupted as often as system request. The minimum timing of tERS must be observed before issuing the next erase suspend command. However, in order for an Erase operation to make progress, tERS ≥ 200us must be included in resume-to-suspend loop(s). Notes. Not 100% tested.

6. Latency time is required to complete Erase/Program Suspend operation.

7. The value guaranteed by characterization, not 100% tested in production.



#### Figure-85. Serial Input Timing



### Figure-86. Output Timing

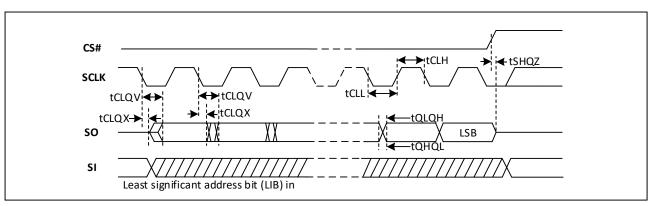
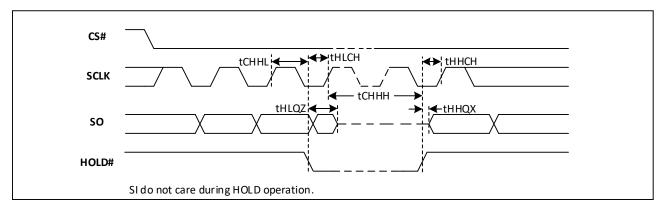
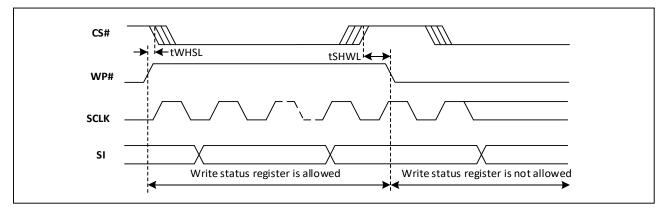


Figure-87. Hold Timing

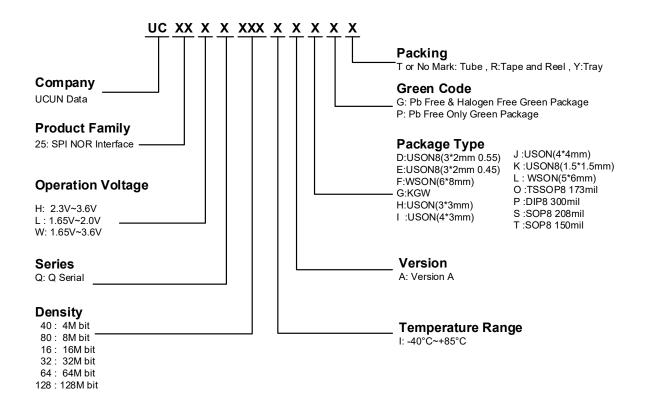


### Figure-88. WP Timing





# **11. ORDERING INFORMATION**

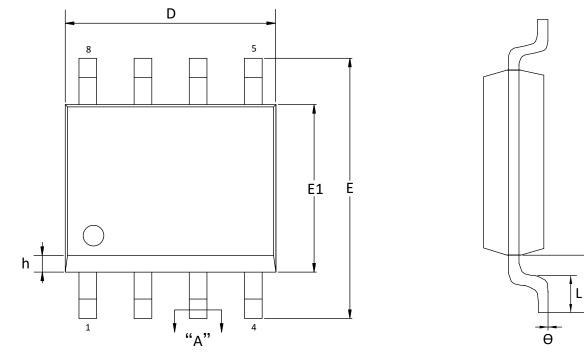


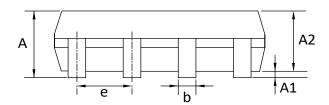


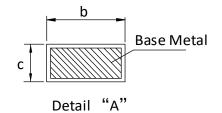
L1

# **12. PACKAGE INFORMATION**

12.1 Package SOP8 150MIL







## Dimensions

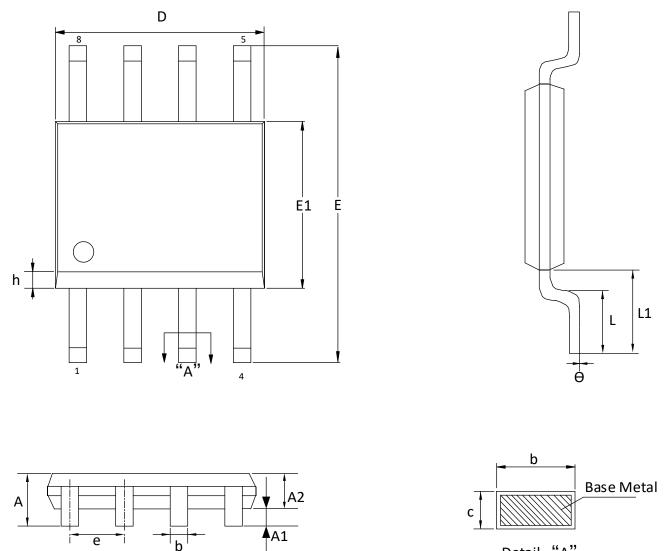
Sy	mbol																							
ι	Jnit	Α	<b>A</b> 1	A2	b	с	D	Е	E1	е	L	L1	h	θ										
	Min	1.35	0.05	1.35	0.38	0.17	4.80	5.80	3.80	1.27	1.27	1.27	1.27								0.50		0.30	0°
mm	Nom	1.55	0.10	1.40	-	-	4.90	6.00	3.90					0.60	1.04	0.40	-							
	Max	1.65	0.15	1.50	0.51	0.25	5.00	6.20	4.00		0.80		0.50	8°										

Note:

- 1. Both the package length and width do not include the mold FLASH.
- 2. Seating plane: Max. 0.25mm.



# 12.2 Package TSSOP8



Detail "A"

# Dimensions

	mbol Jnit	А	A1	A2	b	с	D	E	E1	e	L	L1	h	θ			
	Min		0.05	0.8	0.19	0.09	2.90	6.20	4.30		0.45			0°			
mm	Nom			1.00	-	-	3.00	6.40	4.40	0.65	0.65	0.65	0.65	0.60	1.00		-
	Max	1.2	0.15	1.05	0.30	0.20	3.10	6.60	4.50		0.75			8°			

Note:

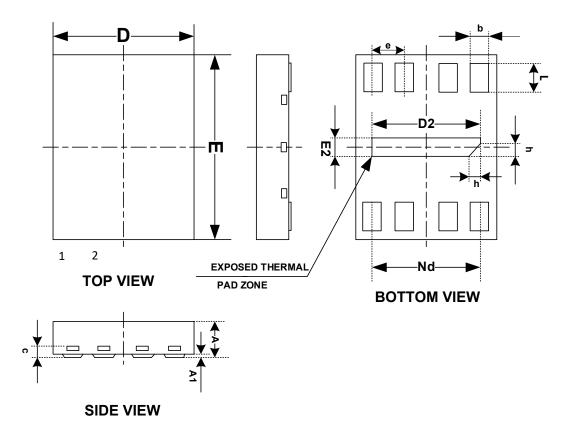
1. Both the package length and width do not include the mold FLASH.

2. Seating plane: Max. 0.25mm.

#### http://www.ucuntech.com



# 12.3 Package USON (3x2x0.55)



# Dimensions

Sym	bol Unit	Α	A1	b	c	D	D2	е	Nd	ш	E2	L	L1	h
	Min	0.5	0	0.2	0.1	1.9	1.5	0.50BSC	BSC 1.50BSC	2.9	0.1	0.3	0.05	0.05
mm	Nom	0.55	0.02	0.25	0.15	2	1.6			3	0.2	0.35	0.1	0.15
	Max	0.6	0.05	0.3	0.2	2.1	1.7			3.1	0.3	0.4	0.15	0.25



# **13. REVISION HISTORY**

Version No	Description	Page	Date		
1.1	Initial Release	All	2021-10-11		
1.2	Modify the AC/DC Parameters table	Page 76~79	2021-11-26		



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